







LMX2694-EP ZHCSKL5D - NOVEMBER 2019 - REVISED MARCH 2022

# LMX2694-EP 具有相位同步功能的 15GHz 宽带 PLLatinum™ 射频合成器

# 1 特性

- VID V62/19616-01XE
- 39.3MHz 至 15.1GHz 输出频率
- 在 100KHz 偏频和 15GHz 载波的情况下具有 -110dBc/Hz 的相位噪声
- 在 8GHz 时, 具有 54fs RMS 抖动 (100Hz 至 100MHz)
- 可编程输出功率
- · PLL 主要规格
  - 品质因数:-236dBc/Hz
  - 归一化 1/f 噪声:-129dBc/Hz
  - 相位检测器频率高达 200MHz
- 跨多个器件实现输出相位同步
- 支持具有 9ps 分辨率可编程延迟的 SYSREF
- 3.3V 单电源运行
- 工作温度范围:-55°C 至 125°C

### 2 应用

- 无线电防御
- 电子战
- 雷达
- 有源天线系统 mMIMO (AAS)
- 宏远程无线电单元
- 室外回程单元
- 数据采集
- 无线通信测试设备

# 3 说明

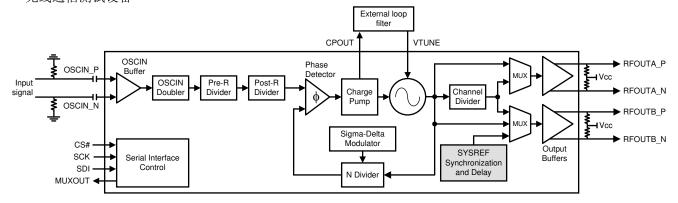
LMX2694-EP 器件是一款集成电压控制振荡器 (VCO) 和稳压器的高性能宽带锁相环 (PLL), 在无倍频器的情 况,可输出 39.3MHz 至 15.1GHz 范围内的任意频 率,从而无需使用 ½ 谐波滤波器。此器件上的 VCO 涵盖了整个倍频区间,因而频率覆盖度可完全低至 39.3MHz。该高性能 PLL 具有 -236dBc/Hz 的品质因 数和高相位检测器频率,可实现非常低的带内噪声和集 成抖动。

LMX2694-EP 允许设计人员同步多个器件实例的输 出。这意味着我们可从任意应用情形下的器件中获得确 定性相位,包括采用分数引擎或启用输出分频器的情 形。该器件还让设计人员可以生成或重复 SYSREF (符合 JESD204B 标准),以便将该器件用作高速数 据转换器的低噪声时钟源。

### 器件信息(1)

器件型号	封装	封装尺寸(标称值)
LMX2694-EP	VQFN (48)	7.00mm × 7.00mm

如需了解所有可用封装,请参阅数据表末尾的可订购产品附 录。



简化版原理图



# **Table of Contents**

1 特性	1	7.5 Programming	26
		7.6 Register Maps	
- <i>—,,,,</i> 3 说明		8 Application and Implementation	<mark>73</mark>
4 Revision History		8.1 Application Information	73
5 Pin Configuration and Functions		8.2 Typical Application	<mark>77</mark>
6 Specifications		9 Power Supply Recommendations	79
6.1 Absolute Maximum Ratings		10 Layout	80
6.2 ESD Ratings		10.1 Layout Guidelines	80
6.3 Recommended Operating Conditions		10.2 Layout Example	<mark>80</mark>
6.4 Thermal Information		11 Device and Documentation Support	81
6.5 Electrical Characteristics		11.1 Device Support	81
6.6 Timing Requirements		11.2 Documentation Support	81
6.7 Timing Diagrams		11.3 接收文档更新通知	81
6.8 Typical Characteristics		11.4 支持资源	81
7 Detailed Description		11.5 Trademarks	81
7.1 Overview		11.6 Electrostatic Discharge Caution	81
7.2 Functional Block Diagram		11.7 术语表	
7.3 Feature Description		12 Mechanical, Packaging, and Orderable	
7.4 Device Functional Modes		Information	<mark>8</mark> 1

**4 Revision History** 注:以前版本的页码可能与当前版本的页码不同

Ch	anges from Revision C (October 2021) to Revision D (March 2022)	Page
•	将 <i>特性</i> 中的 VID V62/19616 可订购型号更改为 "VID V62/19616-01XE"	1
	将 <i>器件信息</i> 表中的 VID V62/19616-01XE 可订购型号移动至数据表末尾的 <i>封装信息</i> 表	
Ch	anges from Revision B (May 2020) to Revision C (October 2021)	Page
•	Removed equivalent division value of 72 in 表 7-8	18
	Changed the JESD_DACx values in 表 7-15	
	Changed the R1 register bit name 3 in 8 7-11 from: 1 to: MUXOUT_CTRL	
	Changed the OUTA_MUX register description in 表 7-65	
	Changed the OUTB_MUX register description in 表 7-66	
Ch	anges from Revision A (December 2019) to Revision B (May 2020)	Page
•	将最大工作温度更改为 125°C	1
	Changed maximum T <sub>C</sub> to 125°C in Recommended Operating Conditions	
	Changed maximum T <sub>C</sub> to 125°C in Electrical Characteristics	
	Changed maximum T <sub>C</sub> to 125°C in Timing Requirements	
Ch	anges from Revision * (November 2019) to Revision A (December 2019)	Page
•	将定制数据表版本更改为产品目录	1

# **5 Pin Configuration and Functions**

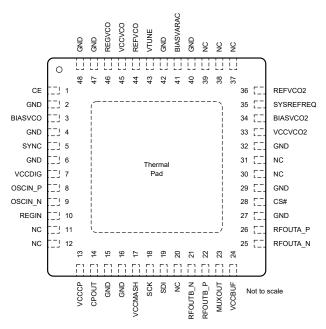


图 5-1. RTC Package 48-Pin VQFN Top View

表 5-1. Pin Functions

	PIN	I/O	DESCRIPTION		
NAME	NO.	1/0	DESCRIPTION		
BIASVARAC	41	BP	VCO varactor bias. Connect a 10-μF decoupling capacitor to ground.		
BIASVCO	3	BP	VCO bias. Connect a 10-μF decoupling capacitor to ground. Place close to pin.		
BIASVCO2	34	BP	VCO bias. Connect a 1-μF decoupling capacitor to ground. Place close to pin.		
CE	1	I	Chip Enable. High impedance CMOS input. 1.8-V to 3.3-V logic. Active HIGH powers on the device.		
CPOUT	14	0	Charge pump output. Recommend connecting C1 of loop filter close to this pin.		
CS#	28	I	PI latch. High impedance CMOS input. 1.8-V to 3.3-V logic.		
GND	2, 4, 32, 40, 42, 47	G	VCO ground.		
GND	6, 16, 48	G	Digital ground.		
GND	15	G	Charge pump ground.		
GND	27, 29	G	Buffer ground.		
MUXOUT	23	0	Multiplexed output. Can output: lock detect, SPI readback and diagnostics.		
NC	11, 12, 20, 30, 31, 37, 38, 39	NC	Pins may be grounded or left unconnected.		
OSCIN_N	9	I	Reference input clock ( - ). High impedance self-biasing pin. Requires AC-coupling capacitor. (0.1 µF recommended)		
OSCIN_P	8	I	Reference input clock (+). High impedance self-biasing pin. Requires AC-coupling capacitor. (0.1 µF recommended)		
REFVCO	44	BP	VCO supply reference. Connect a 10-μF decoupling capacitor to ground.		
REFVCO2	36	BP	VCO supply reference. Connect a 10-µF decoupling capacitor to ground.		
REGIN	10	BP	Input reference path regulator decoupling. Connect a 1-µF decoupling capacitor to ground. Place close to pin.		
REGVCO	46	BP	VCO regulator node. Connect a 1-μF decoupling capacitor to ground.		
RFOUTA_N	25	0	Differential output A ( $^-$ ). Requires connecting 50- $^\Omega$ resistor pullup to $V_{CC}$ as close as possible to pin.		



# 表 5-1. Pin Functions (continued)

	PIN		PIN I/O		DESCRIPTION
NAME	NO.	1/0	DESCRIPTION		
RFOUTA_P	26	0	Differential output A (+). Requires connecting 50- $\Omega$ resistor pullup to $V_{CC}$ as close as possible to pin.		
RFOUTB_N	21	0	Differential output B ( $^-$ ). Requires connecting 50- $^\Omega$ resistor pullup to V <sub>CC</sub> as close as possible to pin.		
RFOUTB_P	22	0	Differential output B (+). Requires connecting 50- $\Omega$ resistor pullup to $V_{CC}$ as close as possible to pin.		
SCK	18	I	SPI clock. High impedance CMOS input. 1.8-V to 3.3-V logic.		
SDI	19	I	SPI data. High impedance CMOS input. 1.8-V to 3.3-V logic.		
SYNC	5	ı	Phase synchronization input. Has programmable threshold. Connect to ground if not being used.		
SYSREFREQ	35	I	SYSREF request input for JESD204B support. Connect to ground if not being used.		
VCCBUF	24	Р	Output buffer supply. Connect to 3.3-V and a 0.1-µF decoupling capacitor to ground.		
VCCCP	13	Р	Charge pump supply. Connect to 3.3-V and a 0.1-µF decoupling capacitor to ground.		
VCCDIG	7	Р	Digital supply. Connect to 3.3-V and a 0.1-µF decoupling capacitor to ground.		
VCCMASH	17	Р	Digital supply. Connect to 3.3-V and a 1-µF decoupling capacitor to ground.		
VCCVCO	45	Р	VCO supply. Connect to 3.3-V and a 1-µF decoupling capacitor to ground.		
VCCVCO2	33	Р	VCO supply. Connect to 3.3-V and a 1-µF decoupling capacitor to ground.		
VTUNE	43	I	VCO tuning voltage input. Connect a 1.5-nF or more capacitor to VCO ground. See External Loop Filter for details.		
Thermal pad	_	_	Connect the GND pin to the exposed thermal pad for correct operation. Connect the thermal pad to any internal PCB ground plane using multiple vias for good thermal performance.		

# **6 Specifications**

# 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)(1)

		MIN	MAX	UNIT
V <sub>CC</sub>	Power supply voltage	- 0.3	3.6	V
V <sub>IN</sub>	IO input voltage		V <sub>CC</sub> + 0.3	V
T <sub>J</sub>	Junction temperature	- 55	150	°C
T <sub>stg</sub>	Storage temperature	- 65	150	°C

<sup>(1)</sup> Stresses beyond those listed under Absolute Maximum Rating may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Condition. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

# 6.2 ESD Ratings

			VALUE	UNIT	
V	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>		±1000	.,	
V <sub>(ESD)</sub>		Charged device model (CDM), per JEDEC specification JESD22-C101, all pins <sup>(2)</sup>	±1000	V	

- (1) JEDEC document JEP155 states that 500 V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250 V CDM allows safe manufacturing with a standard ESD control process.

# **6.3 Recommended Operating Conditions**

over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
T <sub>C</sub>	Case temperature	- 55		125	°C
V <sub>CC</sub>	Supply input voltage	3.2	3.3	3.45	V

#### 6.4 Thermal Information

		LMX2694-EP	
	THERMAL METRIC <sup>(1)</sup>	RTC (VQFN)	UNIT
		48 PINS	
R <sub>0</sub> JA	Junction-to-ambient thermal resistance	22.4	°C/W
R <sub>θ JC(top)</sub>	Junction-to-case (top) thermal resistance	10.0	°C/W
R <sub>0</sub> JB	Junction-to-board thermal resistance	6.1	°C/W
$\Psi_{JT}$	Junction-to-top characterization parameter	0.1	°C/W
Ψ ЈВ	Junction-to-board characterization parameter	6.0	°C/W
R <sub>θ JC(bot)</sub>	Junction-to-case (bottom) thermal resistance	0.7	°C/W

<sup>(1)</sup> For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.



# **6.5 Electrical Characteristics**

 $\underline{3.2~\text{V} \leqslant \text{V}_{\text{CC}} \leqslant 3.45~\text{V},~-50^{\circ}\text{C} \leqslant \text{T}_{\text{C}} \leqslant 125^{\circ}\text{C}.~\text{Typical values are at V}_{\text{CC}} = 3.3~\text{V},~25^{\circ}\text{C}~\text{(unless otherwise noted)}}$ 

	PARAMETER	TEST CONDITION	ONS	MIN	TYP	MAX	UNIT	
POWER SU	JPPLY					-		
I <sub>cc</sub>	Supply current	OUTA_PD = 0; OUTB_PD = 1; OUTA_MUX = OUTB_MUX = 1; OUTA_PWR = 31; CPG = 7; f <sub>OSC</sub> = f <sub>PD</sub> = 100 MHz; f <sub>VCO</sub> = f <sub>OUT</sub> = 14.5 GHz			360		mA	
	Power on reset current	RESET = 1			289			
OUTPUT CHA	Power down current	POWERDOWN = 1		6				
OUTPUT C	HARACTERISTICS							
n	Single-ended output power <sup>(1)</sup>	50- Ω resistor pull-up	f <sub>OUT</sub> = 8 GHz		2		dBm	
POUT	(2)	OUTx_PWR = 31	f <sub>OUT</sub> = 15 GHz		5 1000	ubili		
INPUT SIGI	NAL PATH							
f	Reference input frequency	OSC_2X = 0		5		1000	MHz	
osc		OSC_2X = 1		5		200		
		$f_{OSC} \geqslant 20 \text{ MHz}$		0.4		2		
	Reference input voltage <sup>(3)</sup>	$10 \text{ MHz} \le f_{OSC} < 20 \text{ MHz}$		0.8		2	$V_{PP}$	
		5 MHz ≤ f <sub>OSC</sub> < 10 MHz		1.6		2		
PHASE DE	TECTOR AND CHARGE PUMP	1						
	Di(4)	MASH_ORDER = 0		0.125		250		
V <sub>OSC</sub> F  PHASE DETECT  f <sub>PD</sub> F  I <sub>CPOUT</sub> G	Phase detector frequency <sup>(4)</sup>	MASH_ORDER > 0		5		200	MHz	
	Charge-pump leakage current	CPG = 0			20		nA	
ICPOUT	Effective charge pump current	Sum of the up and down curre	ents	3		15	mA	
PN <sub>PLL_1/f</sub>	Normalized PLL 1/f noise	- 400 MHz. f = 40 CHz(5)			- 129		-ID - /I !	
PN <sub>PLL_FOM</sub>	Normalized PLL noise floor	- I <sub>PD</sub> = 100 MHz; I <sub>VCO</sub> = 12 GHz	100 MHz; f <sub>VCO</sub> = 12 GHz <sup>(5)</sup>		- 236		dBc/Hz	
	ACTERISTICS	1						
f <sub>VCO</sub>	VCO frequency			7550		15100	MHz	

www.ti.com.cn

 $3.2 \text{ V} \le \text{V}_{CC} \le 3.45 \text{ V}, -50 ^{\circ}\text{C} \le \text{T}_{C} \le 125 ^{\circ}\text{C}$ . Typical values are at  $\text{V}_{CC}$  =  $3.3 \text{ V}, 25 ^{\circ}\text{C}$  (unless otherwise noted)

	PARAMETER	TEST CONI	DITIONS	MIN TYP	MAX	UNIT
			100 kHz	- 106.5		
		VCO1	1 MHz	- 128		
		f <sub>VCO</sub> = 8.1 GHz	10 MHz	- 147.5		
			100 MHz	- 154		
			100 kHz	- 105		
		VCO2	1 MHz	- 126.5		
		f <sub>VCO</sub> = 9.3 GHz	10 MHz	- 146.5		
			100 MHz	- 154		
			100 kHz	- 103.5		
		VCO3	1 MHz	- 125.5		
		f <sub>VCO</sub> = 10.4 GHz	10 MHz	- 146		
			100 MHz	- 158		
			100 kHz	- 102.5		
		VCO4	1 MHz	- 124.5		
$PN_{VCO}$	VCO phase noise	f <sub>VCO</sub> = 11.4 GHz	10 MHz	- 145		dBc/Hz
			100 MHz	- 160		
			100 kHz	- 100.5		
		VCO5 f <sub>VCO</sub> = 12.5 GHz	1 MHz	- 122.5		
			10 MHz	- 143.5		
			100 MHz	- 154.5		
			100 kHz	- 99.5		
		VCO6 f <sub>VCO</sub> = 13.6 GHz	1 MHz	- 122		
			10 MHz	- 142.5		
			100 MHz	- 154		
		VCO7 f <sub>VCO</sub> = 14.7 GHz	100 kHz	- 98		
			1 MHz	- 120.5		
			10 MHz	- 141.5		
				- 141.5 - 155		
		Switch across the entire frequency band;		- 155		
VCOCAL	VCO calibration time <sup>(6)</sup>	f <sub>OSC</sub> = f <sub>PD</sub> = 100 MHz; VCO_SEL = 7	equency band,	650		μs
		8.1 GHz		94		
		9.3 GHz		106		
		10.4 GHz		122		
< <sub>vco</sub>	VCO Gain	11.4 GHz		148		MHz/V
		12.5 GHz		185		
		13.6 GHz		202		
		14.7 GHz		233		
∆ T <sub>CL</sub>	Allowable temperature drift	VCO not being re-calibrate		125		°C
<del>1</del> 2	VCO second harmonic	f <sub>VCO</sub> = 8 GHz; divider disa		- 30		dBc
H3	VCO third harmonic	f <sub>VCO</sub> = 8 GHz; divider disa	bled	- 25		
	NTERFACE					
V <sub>IH</sub>	High-level input voltage			1.4		V
√ <sub>IL</sub>	Low-level input voltage				0.4	V



 $3.2~V \le V_{CC} \le 3.45~V,~-50^{\circ}C \le T_{C} \le 125^{\circ}C.$  Typical values are at  $V_{CC}$  = 3.3 V, 25°C (unless otherwise noted)

	PARAMETER	TEST CONDITIO	MIN	TYP MAX	UNIT	
I <sub>IH</sub>	High-level input current			- 100	100	μA
I <sub>IL</sub>	Low-level input current			- 100	100	μΑ
V <sub>OH</sub>	High-level output voltage	Load current = -5 mA	MUXOUT pin	V <sub>CC</sub> - 0.6		V
V <sub>OL</sub>	High-level output current	Load current = 5 mA	WOXOOT PIN		0.6	V

- (1) Single ended output power obtained after de-embedding microstrip trace losses and matching with a manual tuner. Unused port terminated to 50-Ω load.
- (2) Output power, spurs, and harmonics can vary based on board layout and components.
- (3) Single-ended AC coupled sine wave input with complementary side AC coupled to ground with 50-Ω resistor.
- (4) For lower VCO frequencies, the N divider minimum value can limit the phase-detector frequency.
- (5) The PLL noise contribution is measured using a clean reference and a wide loop bandwidth and is composed into flicker and flat components. PLL\_flat = PLL\_FOM + 20 x log(f<sub>VCO</sub>/f<sub>PD</sub>) + 10 x log(f<sub>PD</sub>/1 Hz). PLL\_flicker (offset) = PLL\_1/f + 20 x log(f<sub>VCO</sub>/1 GHz) 10 x log(offset/10 kHz). Once these two components are found, the total PLL noise can be calculated as PLL\_Noise = 10 x log(10<sup>PLL\_Flat/10</sup> + 10<sup>PLL\_flicker/10</sup>).
- (6) See 节 7.3.7.1 for details.

# 6.6 Timing Requirements

 $3.2~V \le V_{CC} \le 3.45~V,~-50°C \le T_{C} \le 125°C.$  Typical values are at  $V_{CC}$  = 3.3 V, 25°C (unless otherwise noted)

			MIN	NOM	MAX	UNIT
SYNC AND S	YSREFREQ TIMING					
t <sub>SETUP</sub>	Setup time for pin relative to OSCIN rising edge	0 20 0 4	9			ns
t <sub>HOLD</sub>	Hold time for pin relative to OSCIN rising edge	See 图 6-1	4			ns
DIGITAL INTE	RFACE WRITE SPECIFICATIONS				'	
f <sub>SPI</sub> Write	SPI write speed	$t_{CWL}$ + $t_{CWH} \geqslant$ 25 ns			40	MHz
t <sub>CE</sub>	Clock to enable low time		5			ns
t <sub>CS</sub>	Data to clock setup time		2			ns
t <sub>CH</sub>	Data to clock hold time		2			ns
t <sub>CWH</sub>	Clock pulse width high	See 图 6-2	5			ns
t <sub>CWL</sub>	Clock pulse width low		5			ns
t <sub>CES</sub>	Enable to clock setup time		5			ns
t <sub>EWH</sub>	Enable pulse width high		2			ns
DIGITAL INTE	RFACE READBACK SPECIFICATIONS				'	
f <sub>SPI</sub> Readback	SPI readback speed				40	MHz
t <sub>CE</sub>	Clock to enable low time		5			ns
t <sub>CS</sub>	Clock to data wait time		2			ns
t <sub>CH</sub>	Clock to data hold time		2			ns
t <sub>CWH</sub>	Clock pulse width high	See 图 6-3	10			ns
t <sub>CWL</sub>	Clock pulse width low		10			ns
t <sub>CES</sub>	Enable to clock setup time		5			ns
t <sub>EWH</sub>	Enable pulse width high		2			ns
t <sub>CD</sub>	Falling clock edge to data wait time				8	ns

Submit Document Feedback

Copyright © 2022 Texas Instruments Incorporated

# 6.7 Timing Diagrams

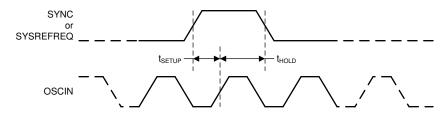


图 6-1. Trigger Signals Timing Diagram

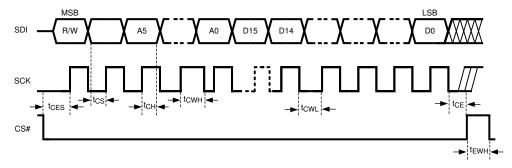


图 6-2. Serial Data Input Timing Diagram

There are several other considerations for writing on the SPI:

- The R/W bit must be set to 0.
- The data on SDI pin is clocked into a shift register on each rising edge on the SCK pin.
- The CS# must be held low for data to be clocked. Device will ignore clock pulses if CS# is held high.
- The CS# transition from high to low must occur when SCK is low.
- When SCK and SDI lines are shared between devices, TI recommends to hold the CS# line high on the device that is not to be clocked.

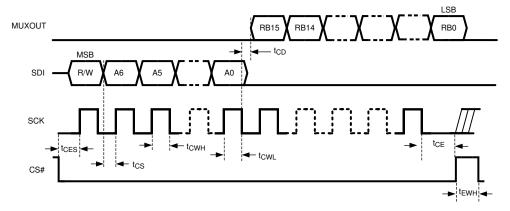


图 6-3. Serial Data Readback Timing Diagram

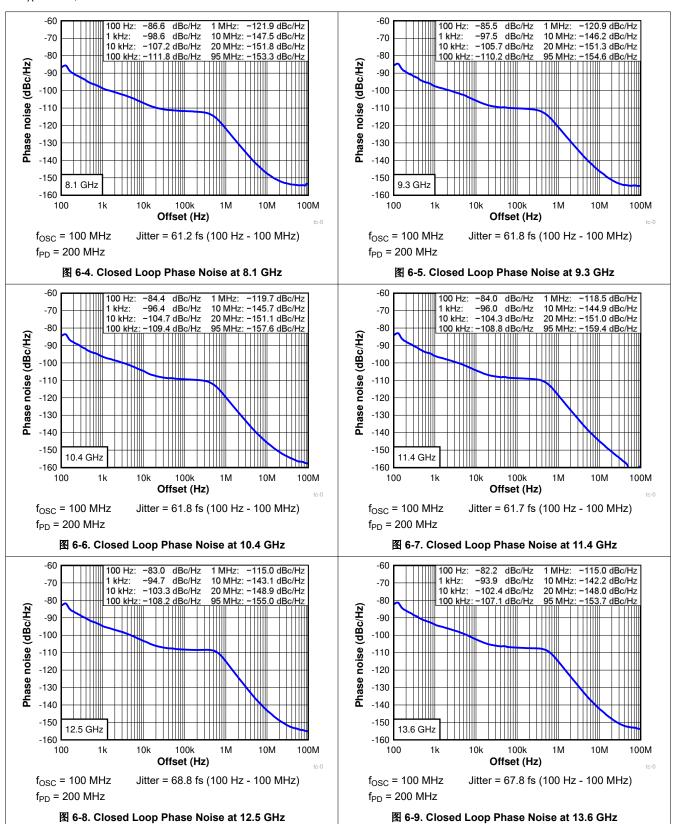
There are several other considerations for SPI readback:

- · The R/W bit must be set to 1.
- The MUXOUT pin will always be low for the address portion of the transaction.
- The data on MUXOUT becomes available momentarily after the falling edge of SCK, and therefore, should be read back on the rising edge of SCK.
- The data portion of the transition on the SDI line is always ignored.



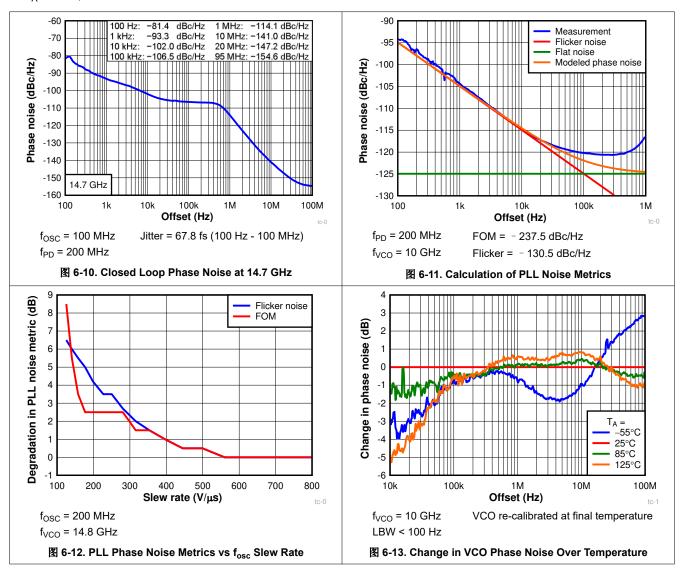
### 6.8 Typical Characteristics

At T<sub>A</sub> = 25°C, unless otherwise noted



# **6.8 Typical Characteristics (continued)**

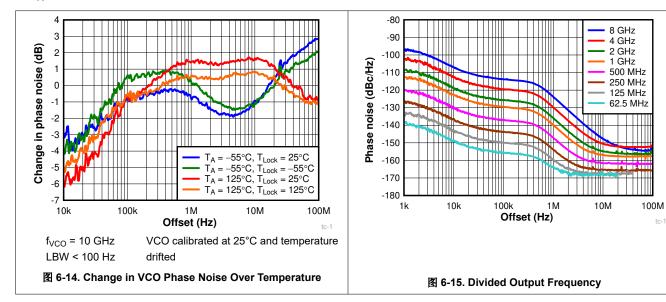
At  $T_A = 25$ °C, unless otherwise noted





# **6.8 Typical Characteristics (continued)**

At T<sub>A</sub> = 25°C, unless otherwise noted



# 7 Detailed Description

### 7.1 Overview

The LMX2694-EP is a high-performance, wideband frequency synthesizer with an integrated VCO and output divider. The VCO operates from 7550 to 15100 MHz, and can be combined with the output divider to produce any frequency in the range of 39.3 MHz to 15.1 GHz. There are two dividers within the input path.

The PLL is fractional-N PLL with a programmable delta-sigma modulator up to the 3<sup>rd</sup> order. The fractional denominator is a programmable 32-bit long that can provide fine frequency steps easily below 1-Hz resolution, as well as be used to do exact fractions like 1/3, 7/1000, and so on.

For applications where deterministic or adjustable phase is desired, the SYNC pin can be used to get the phase relationship between the OSCIN and RFOUTx pins deterministic. Once this is done, the phase can be adjusted in very fine steps of the VCO period divided by the fractional denominator.

The ultra-fast VCO calibration is designed for applications where the frequency must be swept or abruptly changed. The frequency can be manually programmed.

For JESD204B support, the RFOUTB output can be used as a differential SYSREF output that can be either a single pulse or a series of pulses that occur at a programmable distance away from the rising edges of the output signal.

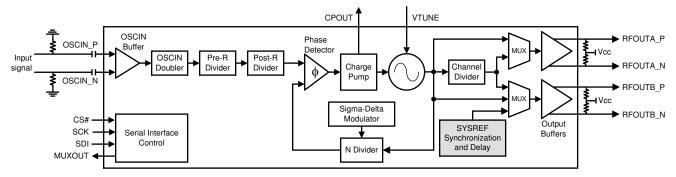
The LMX2694-EP device requires only a single 3.3-V power supply. The internal power supplies are provided by integrated LDOs, eliminating the need for high-performance external LDOs.

表 7-1 shows the range of several of the doubler, dividers, and fractional settings.

表 7-1. Range of Doubler, Divider, and Fractional Settings

PARAMETER	MIN	MAX	COMMENTS
OSCIN doubler	0 (1X)	1 (2X)	The low noise doubler can be used to increase the phase detector frequency to improve phase noise and avoid spurs. This is in reference to the OSC_2X bit.
Pre-R divider	1 (bypass)	128	Only use the Pre-R divider if the input frequency is too high for the Post-R divider.
Post-R divider	1 (bypass)	255	The maximum input frequency for the Post-R divider is 250 MHz. Use the Pre-R divider if necessary.
N divider	≥ 28	524287	The minimum divide depends on modulator order and VCO frequency. See <i>N Divider and Fractional Circuitry</i> for more details.
Fractional numerator / denominator	1 (integer mode)	2 <sup>32</sup> - 1 = 4294967295	The fractional denominator is programmable and can assume any value between 1 and 2 <sup>32</sup> – 1. It is not a fixed denominator.
Fractional order	0	3	Order 0 is integer mode, and the order can be programmed.
Channel divider	1 (bypass)	192	This is the series of several dividers. Also, be aware that above 10 GHz, the maximum allowable channel divider value is 6.
Output frequency	39.3 MHz	15.1 GHz	This is implied by the minimum VCO frequency divided by the maximum channel divider value.

# 7.2 Functional Block Diagram



# 7.3 Feature Description

### 7.3.1 Reference Oscillator Input

The OSCIN pins are used as a frequency reference input to the device. The input is high impedance and requires AC-coupling caps at the pin. The OSCIN pins can be driven single-ended with a CMOS clock or XO. Differential clock input is also supported, making it easier to interface with high-performance system clock devices such as TI's LMK series clock devices. As the OSCIN signal is used as a clock for the VCO calibration, a proper reference signal must be applied at the OSCIN pin at the time of programming FCAL EN.

#### 7.3.2 Reference Path

The reference path consists of an OSCIN doubler (OSC 2X), Pre-R divider, and a Post-R divider.

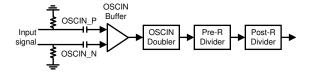


图 7-1. Reference Path Diagram

The OSCIN doubler (OSC\_2X) can double up low OSCIN frequencies. Pre-R (PLL\_R\_PRE) and Post-R (PLL\_R) dividers both divide frequency down. Use 方程式 1 to calculate the phase detector frequency, f<sub>PD</sub>:

$$f_{PD} = f_{OSC} \times OSC \ 2X / (PLL \ R \ PRE \times PLL \ R)$$
 (1)

- If the OSCIN doubler is used, the OSCIN signal should have a 50% duty cycle as both the rising and falling edges are used.
- If the OSCIN doubler is not used, only rising edges of the OSCIN signal are used and duty cycle is not critical.

#### 7.3.2.1 OSCIN Doubler (OSC 2X)

The OSCIN doubler allows the user to double the input reference frequency at up to 400 MHz, while adding minimal noise. It may be advantageous to use the doubler to go higher than the maximum phase detector frequency in some situations, because the Pre-R divider may be able to divide down this frequency to a phase detector frequency that is advantageous for fractional spurs.

#### 7.3.2.2 Pre-R Divider (PLL R PRE)

The Pre-R divider is useful for reducing the input frequency to help meet the maximum 250-MHz input frequency limitation to the PLL-R divider. Otherwise, it does not have to be used.

### 7.3.2.3 Post-R Divider (PLL R)

The Post-R divider can be used to further divide down the frequency to the phase detector frequency. When PLL\_R > 1, the input frequency to this divider is limited to 250 MHz.

#### 7.3.3 State Machine Clock

The state machine clock is a divided-down version of the OSCIN signal that is used internally in the device. This divide value 1, 2, 4, 8, 16, or 32 and is determined by CAL\_CLK\_DIV programming word (described in the *Programming* section). This state machine clock impacts various features like the VCO calibration. The state machine clock is calculated as  $f_{SM} = f_{OSC} / 2^{CAL\_CLK\_DIV}$ .

#### 7.3.4 PLL Phase Detector and Charge Pump

The phase detector compares the outputs of the Post-R divider and N divider, and will generate a correction current corresponding to the phase error until the two signals are aligned in-phase. This charge-pump current is software-programmable to many different levels, which allows the user to modify the closed-loop bandwidth of the PLL.

# 7.3.5 N Divider and Fractional Circuitry

The N divider includes fractional compensation that can achieve any fractional denominator from 1 to  $(2^{32}-1)$ . The integer portion of N is the whole part of the N divider value, while the fractional portion ( $N_{frac}$  = NUM / DEN) is the remaining fraction. In general, the total N divider value is determined by N + NUM / DEN. The N, NUM and DEN are software-programmable. The higher the denominator, the finer the resolution step of the output. For example, even when using  $f_{PD}$  = 200 MHz, the output can increment in steps of 200 MHz / ( $2^{32}-1$ ) = 0.047 Hz. 1 2 shows the relationship between the phase detector and VCO frequencies. Note that in SYNC mode, there is an extra divider that is not shown in 2 2

$$f_{VCO} = f_{PD} \times [N + NUM/DEN]$$
 (2)

The sigma-delta modulator that controls this fractional division is also programmable from integer mode to the third order. To make the fractional spurs consistent, the modulator is reset any time that the R0 register is programmed.

The N divider has minimum value restrictions based on the modulator order (MASH\_ORDER) and VCO frequency. Furthermore, the PFD\_DLY\_SEL bit must be programmed in accordance to 表 7-2. IncludedDivide may be larger than one in SYNC mode. In all other modes, IncludedDivide is just one.

MASH_ORDER	f <sub>VCO</sub> / IncludedDivide (MHz)	MINIMUM N	PFD_DLY_SEL
0	≤ 12500	29	1
O O	> 12500	33	2
	≤ 10000	30	1
1	10000 - 12500	34	2
	> 12500	38	3
	≤ 4000 (SYNC mode)	31	1
2	4000 - 7500 (SYNC mode)	31	2
2	7500 - 10000	32	2
	> 10000	36	3
	≤ 4000 (SYNC mode)	33	1
3	4000 - 7500 (SYNC mode)	37	2
	7500 - 10000	41	3
	> 10000	45	4

表 7-2. Minimum N Divider Restrictions

#### 7.3.6 MUXOUT Pin

The MUXOUT pin can be configured as either a lock detect indicator for the PLL or as a serial data output for the SPI interface to read back registers. Field MUXOUT\_LD\_SEL (register R0[2]) configures this output.



表 7-3. MUXOUT Pin Configurations

MUXOUT_LD_SEL	FUNCTION
0	Serial data output for readback
1	Lock detect indicator

When the lock detect indicator is selected, there are two types of indicators that can be selected with the field LD\_TYPE (register R59[0]). The first indicator is called "VCOCal" (LD\_TYPE = 0), and the second indicator is called "Vtune and VCOCal" (LD\_TYPE = 1).

#### 7.3.6.1 Serial Data Output for Readback

In this mode, the MUXOUT pin can be used as a the serial data output of the SPI interface. This output cannot be in a tri-state condition, therefore no line sharing is possible. Details of this pin operation are described in *Timing Requirements*. Readback is very useful when a device is used in full-assist mode, because the VCO calibration data are retrieved and saved for future use. It can also be used to read back the lock detect status using the field rb\_LD\_VTUNE(register R110[10:9]).

# 7.3.6.2 Lock Detect Indicator Set as Type "VCOCal"

In this mode, the MUXOUT pin will be low when the VCO is calibrating or when the lock detect delay timer is running. Otherwise, the MUXOUT will be high. The programmable timer (LD\_DLY, register R60[15:0]) adds an additional delay after the VCO calibration finishes and before the lock detect indicator is asserted high. LD\_DLY is a 16-bit unsigned quantity that corresponds to the 4 times the number of phase detector cycles in absolute delay. For example, a phase detector frequency of 100 MHz and the LD\_DLY = 10000 will add a delay of 400 µs before the indicator is asserted. This indicator will remain in its current state (high or low) until register R0 is programmed with FCAL\_EN = 1 with a valid input reference. In other words, if the PLL goes out of lock or the input reference goes away when the current state is high, then the current state will remain high.

### 7.3.6.3 Lock Detect Indicator Set as Type "Vtune and VCOCal"

In this mode the MUXOUT pin will be high when the VCO calibration has finished, the lock detect delay timer is finished running, and the PLL is locked. This indicator may remain in its current state (high or low) if the OSCin signal is lost. The true status of the indicator will be updated and resume its operation only when a valid input reference to the OSCin pin is returned. An alternative method to monitor the OSCin of the PLL is recommended. This indicator is reliable as long as the reference to OSCin is present.

The output of the device can be automatically muted when lock detect indicator "Vtune and VCOCal" is low. This feature is enabled with the field OUT\_MUTE (register R0[9]) asserted.

### 7.3.7 VCO (Voltage-Controlled Oscillator)

The LMX2694-EP includes a fully integrated VCO. The VCO takes the voltage from the loop filter and converts this into a frequency. The VCO frequency is related to the other frequencies and as follows:

$$f_{VCO} = f_{PD} \times N \text{ divider} \times \text{IncludedDivide}$$
 (3)

#### 7.3.7.1 VCO Calibration

To reduce the VCO tuning gain, and therefore improve the VCO phase-noise performance, the VCO frequency range is divided into several different frequency bands. The entire range (7550 to 15100 MHz) covers an octave that allows the divider to take care of frequencies below the lower bound. This creates the need for frequency calibration to determine the correct frequency band given a desired output frequency. The frequency calibration routine is activated any time that the R0 register is programmed with the FCAL\_EN = 1. It is important that a valid OSCIN signal must present before VCO calibration begins.

The VCO also has an internal amplitude calibration algorithm to optimize the phase noise, which is also activated any time the R0 register is programmed.

The optimum internal settings for this are temperature-dependent. If the temperature is allowed to drift too much without being recalibrated, some minor phase noise degradation could result. The maximum allowable drift for

continuous lock,  $\triangle T_{CL}$ , is stated in the electrical specifications. For this device, a number of 125°C means the device never loses lock if the device is operated under recommended operating conditions.

The LMX2694-EP allows the user to assist the VCO calibration. In general, there are three kinds of assistance, as shown in  $\frac{1}{8}$  7-4.

表 7-4. Assisting the VCO	Calibration Speed
--------------------------	-------------------

ASSISTANCE LEVEL	DESCRIPTION	VCO_SEL	VCO_SEL_FORCE VCO_CAPCTRL_FORCE VCO_DACISET_FORCE	VCO_CAPCTRL VCO_DACISET
No assist	User does nothing to improve VCO calibration speed.	7	0	Don't care
Partial assist	Upon every frequency change, before the FCAL_EN bit is checked, the user provides the initial starting VCO_SEL.	Choose by table	0	Don't care
Full assist	The user forces the VCO core (VCO_SEL), amplitude settings (VCO_DACISET), and frequency band (VCO_CAPCTRL) and manually sets the value.	Choose by readback	1	Choose by readback

For the no-assist method, just set VCO\_SEL = 7 and this is done. For partial-assist, the VCO calibration speed can be improved by changing the VCO\_SEL bit according to frequency. Note that the frequency is not the actual VCO core range, but actually favors choosing the VCO. This is not only optimal for VCO calibration speed, but required for reliable locking.

表 7-5. Minimum VCO\_SEL for Partial Assist

f <sub>VCO</sub>	VCO CORE (MIN)
7550 - 8740 MHz	VCO1
8740 - 10000 MHz	VCO2
10000 - 10980 MHz	VCO3
10980 - 12100 MHz	VCO4
12100 - 13080 MHz	VCO5
13080 - 14180 MHz	VCO6
14180 - 15100 MHz	VCO7

For fastest calibration time, it is ideal to use the minimum VCO core as recommended in  $\frac{1}{8}$  7-5. The  $\frac{1}{8}$  7-6 shows typical VCO calibration times (in  $\mu$ s) for this choice in bold as well as showing how long the calibration time is increased if a higher than necessary VCO core is chosen. Realize that these calibration times are specific to these  $f_{OSC}$  and  $f_{PD}$  conditions specified and at the boundary of two cores, sometimes the calibration time can be increased.

表 7-6. Typical Calibration Times for f<sub>OSC</sub> = f<sub>PD</sub> = 100 MHz Based on VCO\_SEL

f <sub>VCO</sub> (GHz)			VCO_SEL					
IVCO (GHZ)	VCO7	VCO6	VCO5	VCO4	VCO3	VCO2	VCO1	
8.1	650	540	550	440	360	230	110	
9.3	610	530	540	430	320	220	Invalid	
10.4	590	520	530	430	240 Invalid			
11.4	340	290	280	180	180 Invalid			
12.5	270	170	120 Invalid					
13.6	240	130	Invalid					
14.7	160			Inv	alid			

#### 7.3.7.2 Determining the VCO Gain

The VCO gain varies between the seven cores, and is the lowest at the lowest end of the band and highest at the highest end of each band. For a more accurate estimation, use  $\frac{1}{8}$  7-7.



表 7-7. VCO Gain
-----------------

f1	f2	K <sub>vco</sub> 1	K <sub>VCO</sub> 2
7550	8740	78	114
8740	10000	91	125
10000	10980	112	136
10980	12100	136	168
12100	13080	171	206
13080	14180	188	218
14180	15100	218	248

Based ion 表 7-7, 方程式 4 can estimate the VCO gain for an arbitrary VCO frequency of f<sub>VCO</sub>:

$$K_{VCO} = K_{VCO}1 + (K_{VCO}2 - K_{VCO}1) \times (f_{VCO} - f_1) / (f_2 - f_1)$$
 (4)

#### 7.3.8 Channel Divider

To go below the VCO lower bound of 7550 MHz, the channel divider can be used. The channel divider consists of four segments, and the total division value is equal to the multiplication of them. Therefore, not all values are valid.

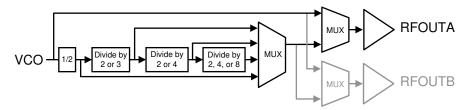


图 7-2. Channel Divider

When the channel divider is used, there are limitations on the values.  $\gtrsim$  7-8 shows how these values are implemented and which segments are used.

表 7-8. Channel Divider Segments

EQUIVALENT	FREQUENCY	OUTPUT FREQUENCY (MHz)	CHDIV[4:0]	SEG0	SEG1	SEG2	SEG3	
DIVISION VALUE	LIMITATION	MIN	MAX	CHDIV[4.0]	SEGU	SEGI	SEG2	3203
2		3775	7550	0	2	1	1	1
4	None	1887.5	3775	1	2	2	1	1
6		1258.333	2516.667	2	2	3	1	1
8		943.75	1437.5	3	2	2	2	1
12	f <sub>VCO</sub> ≤ 11.5 GHz	629.167	958.333	4	2	3	2	1
16		471.875	718.75	5	2	2	4	1
24		314.583	469.167	6	2	3	4	1
32		235.938	359.375	7	2	2	8	1
48		157.292	239.583	8	2	3	8	1
64		117.969	179.688	9	2	2	8	2
96		78.646	119.792	10	2	3	8	2
128		58.984	89.844	11	2	2	8	4
192		39.323	59.896	12	2	3	8	4
Invalid	n/a	n/a	n/a	13 - 31	n/a	n/a	n/a	n/a

Submit Document Feedback

Copyright © 2022 Texas Instruments Incorporated

The channel divider is powered up whenever an output (OUTx\_MUX) is selected to the channel divider or SYSREF, regardless of whether it is powered down or not. When an output is not used, TI recommends selecting the VCO output to ensure that the channel divider is not unnecessarily powered up.

表 7-9. Channel Divider

OUTA MUX	OUTB MUX	CHANNEL DIVIDER
Channel Divider	X	Powered up
X	Powered up	
All other	Powered down	

#### 7.3.9 Output Buffer

The RF output buffer type is open-collector that requires an external pullup to V<sub>CC</sub>. This component may be a 50-Ω resistor or an inductor. The inductor has less controlled impedance, but higher power. For the inductor case, it is often helpful to follow this with a resistive pad. The output power can be programmed to various levels or disabled while still keeping the PLL in lock.

表 7-10. OUTx\_PWR Recommendations

f <sub>OUT</sub>	RESTRICTIONS	COMMENTS							
10 MHz $\leqslant$ f <sub>OUT</sub> $\leqslant$ 5 GHz	None	At lower frequencies, the output buffer impedance is high, so the 50- $\Omega$ pullup will make the output impedance look somewhat like 50 $\Omega$ .							
$5  \mathrm{GHz} \leqslant \mathrm{f_{OUT}} \leqslant 10  \mathrm{GHz}$	OUTx_PWR ≤ 31	In this range, parasitic inductances have some impact, so the output setting is restricted.							
10 GHz < f <sub>OUT</sub>	OUTx_PWR ≤ 20	At these higher frequency ranges, it is best to keep below 20 for highest power and optimal noise floor.							

#### 7.3.10 Powerdown Modes

The LMX2694-EP can be powered up and down using the CE pin or the POWERDOWN bit. When the device comes out of the powered-down state, either by resuming the POWERDOWN bit to zero or by pulling back CE pin HIGH (if it was powered down by CE pin), register R0 must be programmed with FCAL EN high again to recalibrate the device.

#### 7.3.11 Treatment of Unused Pins

This device has several pins for many features and there is a preferred way to treat these pins if not needed. For the input pins, a series resistor is recommend, but they can be directly shorted.

表 7-11. Recommended Treatment of Pins

PINS	RECOMMENDED TREATMENT IF NOT USED
CE	$V_{CC}$ with 1 k $\Omega$ .
SYNC, SYSREFREQ	Ground with 1 k $\Omega$ .
OSCIN_P, OSCIN_N	Ground with 50 $^{\Omega}$ after AC-coupling capacitors. If one of the complimentary sides is used and other side is not, impedance looking out should be similar for both of these pins.
SCK, SDI	Ground with 1 k $\Omega$ .
CS#	$V_{CC}$ with 1 k $\Omega$ .
RFOUTx	$V_{CC}$ with 50 $\Omega$ . If one of the complimentary sides is used and the other side is not, impedance looking out should be similar for both of these pins.
MUXOUT	Ground with 10 k Ω.

### 7.3.12 Phase Synchronization

#### 7.3.12.1 General Concept

The SYNC pin allows the user to synchronize the LMX2694-EP such that the delay from the rising edge of the OSCIN signal to the output signal is deterministic. Initially, the devices are locked to the input, but are not synchronized. The user sends a synchronization pulse that is reclocked to the next rising edge of the OSCIN

pulse. After a given time,  $t_1$ , the phase relationship from OSCIN to  $f_{OUT}$  will be deterministic. This time is dominated by the sum of the VCO calibration time, the analog setting time of the PLL loop, and the MASH RST CNT if used in fractional mode.

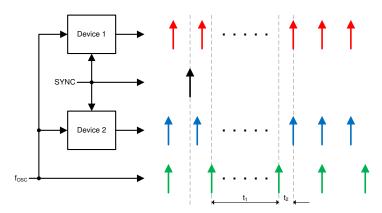


图 7-3. Phase SYNC Mechanism

When the SYNC feature is enabled, part of the channel divide may be included in the feedback path.

表 7-12. IncludedDivide With VCO\_PHASE\_SYNC = 1

OUTx_MUX	CHANNEL DIVIDER	IncludedDivide		
OUTA_MUX = OUTB_MUX = 1 ("VCO")	Don't care	1		
All other valid conditions	Divisible by 3 but NOT 24 or 192	SEG0 x SEG1 = 6		
All other valid conditions	All other values	SEG0 x SEG1 = 4		

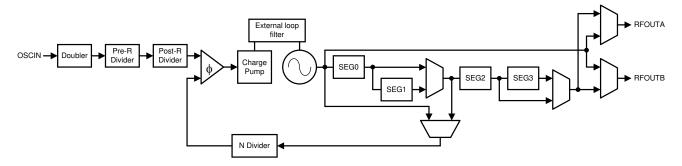


图 7-4. Phase SYNC Diagram

#### 7.3.12.2 Categories of Applications for SYNC

The requirements for SYNC depend on certain setup conditions. In cases that the SYNC is not timing critical, it can be done through software by toggling the VCO\_PHASE\_SYNC bit from 0 to 1. 🗵 7-5 gives the different categories. When it is timing critical, then it must be done through the pin and the setup and hold times for the OSCIN pin are critical. For timing critical SYNC (Category 3 only), adhere to the following guidelines.

表 7-13. SYNC Pin Timing Characteristics for Category 3 SYNC

	PARAMETER	MIN	MAX	UNIT
f <sub>OSC</sub>	Input reference frequency		40	MHz
t <sub>SETUP</sub>	Setup time between SYNC and OSCIN rising edges	9		ns
t <sub>HOLD</sub>	Hold time between SYNC and OSCIN rising edges	4		ns

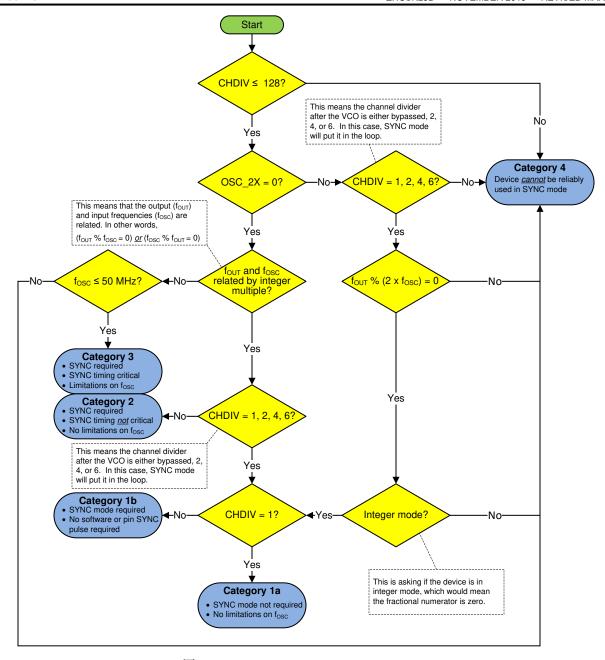


图 7-5. Determining the SYNC Category

### 7.3.12.3 Procedure for Using SYNC

This procedure must be used to put the device in SYNC mode.

- 1. Use the flowchart to determine the SYNC category.
- 2. Make determinations for OSCIN and using SYNC based on the category.
  - a. If category 4, SYNC cannot be performed in this setup.
  - b. If category 3, ensure that the maximum f<sub>OSC</sub> frequency for SYNC is not violated and there are hardware accommodations to use the SYNC pin.
- 3. If the channel divide is used, determine the included channel divide value which will be 2 × SEG1 of the channel divide.
  - a. If OUTA\_MUX is not channel divider and OUTB\_MUX is not channel divider or SYSREF, then IncludedDivide = 1.

- b. Otherwise, IncludedDivide = 2 × SEG1. In the case that the channel divider is 2, then IncludedDivide = 4.
- 4. If not done already, divide the N divider and fractional values by the included channel divide to account for the included channel divide.
- 5. Program the device with the VCO\_PHASE\_SYNC = 1. Note that this does not count as applying a SYNC to device (for category 2).
- 6. Apply the SYNC, if required.
  - a. If category 2, VCO\_PHASE\_SYNC can be toggled from 0 to 1. Alternatively, a rising edge can be sent to the SYNC pin and the timing of this is not critical.
  - b. If category 3, the SYNC pin must be used, and the timing must be away from the rising edge of the OSCIN signal.

#### 7.3.12.4 SYNC Input Pin

If not using SYNC mode (VCO\_PHASE\_SYNC = 0), the INPIN\_IGNORE bit must be set to one, otherwise it causes issues with lock detect. If the pin is desired for to be used and VCO\_PHASE\_SYNC = 1, then set  $INPIN_IGNORE = 0$ .

# 7.3.13 Phase Adjust

The MASH\_SEED word can use the sigma-delta modulator to shift output signal phase with respect to the input reference. If a SYNC pulse is sent (software or pin) or the MASH is reset with MASH\_RST\_N, then this phase shift is from the initial phase of zero. If the MASH\_SEED word is written to, then this phase is added. The phase shift is calculated as below.

For example:

MASH SEED = 1; PLL DEN = 12; CHDIV = 16

If VCO PHASE SYNC = 0, Phase shift = 360 × (1 / 12) × (1 / 16) = 1.875 degrees.

If VCO\_PHASE\_SYNC = 1, Phase shift =  $360 \times (1/12) \times (4/16) = 7.5$  degrees.

There are several considerations when using MASH\_SEED.

- Phase shift can be done with a PLL\_NUM = 0, but MASH\_ORDER must be greater than zero. For MASH\_ORDER = 1, the phase shifting only occurs when MASH\_SEED is a multiple of PLL\_DEN.
- For the  $2^{nd}$  order modulator, PLL N  $\geq$  45. For the  $3^{rd}$  order modulator, PLL N  $\geq$  49.

When using MASH\_SEED in the case where IncludedDivide > 1, there are several additional considerations in order to get the phase shift to be monotonically increasing with MASH\_SEED.

- TI recommends to use MASH\_ORDER ≤ 2.
- When using the 2<sup>nd</sup> order modulator for VCO frequencies below 10 GHz (when IncludedDivide = 6) or 9 GHz (when IncludedDivide = 4), it may be necessary to increase the PLL\_N value much higher or change to the 1<sup>st</sup> order modulator. When this is necessary depends on the VCO frequency, IncludedDivide, and PLL\_N value.

# 7.3.14 Fine Adjustments for Phase Adjust and Phase SYNC

Phase SYNC refers to the process of getting the same phase relationship for every power up cycle and each time assuming that a given programming procedure is followed. However, there are some adjustments that can be made to get the most accurate results. As for the consistency of the phase SYNC, the only source of variation could be if the VCO calibration chooses a different VCO core and capacitor, which can introduce a bimodal distribution with about 10 ps of variation. If this 10 ps is not desirable, then it can be eliminated by reading back the VCO core, capcode, and DACISET values and forcing these values to ensure the same calibration settings every time. The delay through the device varies from part to part and can be on the order of 60 ps. This part to part variation can be calibrated out with the MASH\_SEED. The variation in delay through the device also changes on the order of +2.5 ps/°C, but devices on the same board likely have similar temperatures, so this will somewhat track. In summary, the device can be made to have consistent delay through the part and there are

means to adjust out any remaining errors with the MASH\_SEED. This tends only to be an issue at higher output frequencies when the period is shorter.

#### **7.3.15 SYSREF**

The LMX2694-EP can generate a SYSREF output signal that is synchronized to f<sub>OUT</sub> with a programmable delay. This output can be a single pulse, series of pulses, or a continuous stream of pulses. To use the SYSREF capability, the PLL must first be placed in SYNC mode with VCO PHASE SYNC = 1.

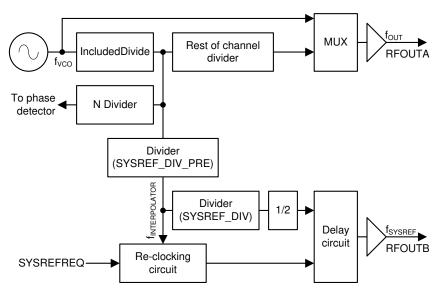


图 7-6. SYSREF Setup

As  $\[ \]$  7-6 shows, the SYSREF feature uses IncludedDivide and SYSREF\_DIV\_PRE divider to generate f<sub>INTERPOLATOR</sub>. This frequency is used for re-clocking of the rising and falling edges at the SYSREFREQ pin. In master mode, the f<sub>INTERPOLATOR</sub> is further divided by 2 × SYSREF\_DIV to generate finite series or continuous stream of pulses.

PARAMETER	MIN	TYP	MAX	UNIT
f <sub>VCO</sub>	7550		15100	MHz
f <sub>INTERPOLATOR</sub>	0.8		1.5	GHz
IncludedDivide		4 or 6		
SYSREF_DIV_PRE		1, 2, or 4		
SYSREF_DIV		4, 6, 8,, 4098		
f <sub>INTERPOLATOR</sub>	f <sub>INTERPOLATOR</sub> = f	VCO / (IncludedDivide × S	YSREF_DIV_PRE)	
f <sub>SYSREF</sub>	f <sub>SYSREF</sub> =	f <sub>INTERPOLATOR</sub> / (2 × SYS	SREF_DIV)	
Delay step size		9		ps
Pulses for pulsed mode (SYSREF_PULSE_CNT)	0		15	

表 7-14. SYSREF Setup

The delay can be programmed using the JESD\_DAC1\_CTRL, JESD\_DAC2\_CTRL, JESD\_DAC3\_CTRL, and JESD\_DAC4\_CTRL words. By concatenating these words into a larger word called "SYSREFPHASESHIFT", the relative delay can be found. The sum of these words must always be 63.

表 7-15. SYSREF Delay

SYSREFPHASESHIFT	DELAY	JESD_DAC1	JESD_DAC2	JESD_DAC3	JESD_DAC4
0	Minimum	36	27	0	0
				0	0

Copyright © 2022 Texas Instruments Incorporated

Submit Document Feedback

表 7-15. SYSREF Delay (continued)

SYSREFPHASESHIFT	DELAY	JESD_DAC1	JESD_DAC2	JESD_DAC3	JESD_DAC4
36		0	63	0	0
37		0	62	1	0
99		0	0	63	0
100		0	0	62	1
161		0	0	1	62
162		0	0	0	63
163		1	0	0	62
225		63	0	0	0
226		62	1	0	0
247	Maximum	41	22	0	0
> 247	Invalid	Invalid	Invalid	Invalid	Invalid

# 7.3.15.1 Programmable Fields

表 7-16 has the programmable fields for the SYSREF functionality.

表 7-16. SYSREF Programming Fields

	~ ·	10.0.0.	i rogramming i icias						
FIELD	PROGRAMMING	DEFAULT	DESCRIPTION						
SYSREF_EN	0 = Disabled 1 = Enabled	0	Enables the SYSREF mode. SYSREF_EN must be 1 if and only if OUTB_MUX = 2 (SYSREF).						
SYSREF_DIV_PRE	1 = DIV1 2 = DIV2 4 = DIV4 Other states = Invalid		The output of this divider is the f <sub>INTERPOLATOR</sub> .						
SYSREF_REPEAT	0 = Master mode 1 = Repeater mode	0	In master mode, the device creates a series of SYSREF pulses. In repeater mode, SYSREF pulses are generated with the SYSREFREQ pin.						
SYSREF_PULSE	0 = Continuous mode 1 = Pulsed mode	0	Continuous mode continuously makes SYSREF pulses, where pulsed mode makes a series of SYSREF_PULSE_CNT pulses						
SYSREF_PULSE_CNT	0 to 15	4	In the case of using pulsed mode, this is the number of pulses. Setting this to zero is an allowable, but not practical state.						
SYSREF_DIV	0 = Divide by 4 1 = Divide by 6 2 = Divide by 8  2047 = Divide by 4098	0	The SYSREF frequency is at the VCO frequency divided by this value.						

# 7.3.15.2 Input and Output Pin Formats

# 7.3.15.2.1 SYSREF Output Format

The SYSREF output comes in differential format through RFOUTB. This will have a minimum voltage of about 2.3 V and a maximum of 3.3 V. If DC coupling cannot be used, there are two strategies for AC coupling.

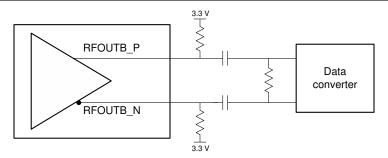


图 7-7. SYSREF Output

- 1. Send a series of pulses to establish a DC-bias level across the AC-coupling capacitor.
- 2. Establish a bias voltage at the data converter that is below the threshold voltage by using a resistive divider.

# 7.3.15.3 SYSREF Examples

The SYSREF can be used in a repeater mode, which just echos the input, after the SYSREF is reclocked to the f<sub>INTERPOLATOR</sub> frequency and then RFOUT—or it can be used in a repeater. In repeater mode, it can repeat 1, 2, 4, 8, or infinite (continuous) pulses. The frequency for repeater mode is equal to the RFOUT frequency divided by the SYSREF divider.

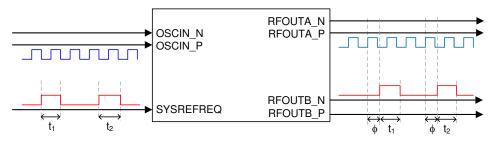


图 7-8. SYSREF Out in Repeater Mode

In master mode, the SYSREFREQ pin is pulled high to allow the SYSREF output.

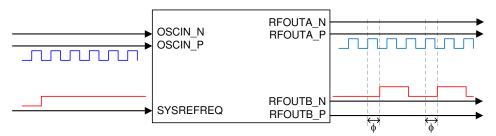


图 7-9. SYSREF Out in Pulsed / Continuous Mode

#### 7.3.15.4 SYSREF Procedure

To use SYSREF, do the these steps:

- 1. Put the device in SYNC mode using the procedure already outlined.
- 2. Figure out IncludedDivide the same way it is done for SYNC mode.
- 3. Calculate the SYSREF\_DIV\_PRE value such that the interpolator frequency (f<sub>INTERPOLATOR</sub>) is in the range of 800 to 1500 MHz. f<sub>INTERPOLATOR</sub> = f<sub>VCO</sub> / IncludedDivide / SYSREF\_DIV\_PRE. Make this frequency a multiple of f<sub>OSC</sub> if possible.
- 4. If using master mode (SYSREF\_REPEAT = 0), ensure SYSREFREQ pin is high.
- 5. If using repeater mode (SYSREF\_REPEAT = 1), set up the pulse count if desired. Pulses are created by toggling the SYSREFREQ pin.
- Adjust the delay between the RFOUTA and RFOUTB signal using the JESD\_DACx\_CTRL fields.

### 7.4 Device Functional Modes

表 7-17 shows the function modes of the LMX2694-EP.

#### 表 7-17. Functional Modes

MODE	DESCRIPTION	SOFTWARE SETTINGS
RESET	Registers are held in their reset state. This device does have a power-on reset, but it is good practice to also do a software reset if there is any possibility of noise on the programming lines, especially if there is sharing with other devices. Also realize that there are registers not disclosed in the data sheet that are reset as well.	RESET = 1 POWERDOWN = 0
POWERDOWN	Device is powered down.	POWERDOWN = 1
Normal operating mode	This is used with at least one output on as a frequency synthesizer and the device can be controlled through the SPI interface.	
SYNC mode	This is used where part of the channel divider is in the feedback path to ensure deterministic phase.	VCO_PHASE_SYNC = 1
SYSREF mode	In this mode, RFOUTB is used to generate pulses for SYSREF.	VCO_PHASE_SYNC =1 SYSREF_EN = 1

### 7.5 Programming

The LMX2694-EP is programmed using 24-bit shift registers. The shift register consists of a R/W bit (MSB), followed by a 7-bit address field and a 16-bit data field. For the R/W bit, 0 is for write, and 1 is for read. The address field ADDRESS[6:0] is used to decode the internal register address. The remaining 16 bits form the data field DATA[15:0]. While CS# is low, serial data is clocked into the shift register upon the rising edge of clock (data is programmed MSB first). When CS# goes high, data is transferred from the data field into the selected register bank. See 86-2 for timing details.

#### 7.5.1 Recommended Initial Power-Up Sequence

For the most reliable programming, TI recommends this procedure:

- 1. Apply power to device.
- 2. Program RESET = 1 to reset registers.
- 3. Program RESET = 0 to remove reset.
- 4. Program registers as shown in the register map in REVERSE order from highest to lowest.
- 5. Programming of registers R113 down to R79 is not required, but if they are programmed, they should be done so as the register map shows. Programming of registers R79 down to R0 is required. Registers in this range that only 1's and 0's should also be programmed in accordance to the register map. Do NOT assume that the power-on reset state and the recommended value are the same.
- 6. Wait 10 ms.
- 7. Program register R0 one additional time with FCAL\_EN = 1 to ensure that the VCO calibration runs from a stable state.

### 7.5.2 Recommended Sequence for Changing Frequencies

The recommended sequence for changing frequencies is as follows:

- 1. Change the N-divider value.
- 2. Program the PLL numerator and denominator.
- 3. Program  $FCAL_EN(R0[3]) = 1$ .



# 7.6 Register Maps

DEO								DATA[1	5:0]								DOD
REG.	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	POR
R0	0	VCO_PHASE_ SYNC	1	0	0	0	OUT_MUTE	FCAL_H	PFD_ADJ	0	0	1	FCAL_EN	MUXOUT_ LD_SEL	RESET	POWER DOWN	0x200C
R1	0	0	0	0	1	0	0	0	0	0	0	0	MUXOUT_C TRL	C	CAL_CLK_DIV		
R2	0	0	0	0	0	1	0	1	0	0	0	0	0	0	0	0	0x500
R3	0	0	0	0	0	1	1	0	0	1	0	0	0	0	1	0	0x642
R4	0	0	0	0	1	1	1	0	0	1	0	0	0	0	1	1	0xA43
R5	0	0	0	0	0	0	1	1	1	1	1	0	1	0	0	0	0xC8
R6	0	1	1	1	1	0	0	0	0	0	0	0	0	0	1	0	0xC802
R7	0	0	0	0	0	0	0	0	1	0	1	1	0	0	1	0	0xB2
R8	0	VCO_ DACISET_ FORCE	1	0	VCO_ CAPCTRL_ FORCE	0	0	0	0	0	0	0	0	0	0	0	0x2000
R9	0	0	0	OSC_2X	0	1	1	0	0	0	0	0	0	1	0	0	0x604
R10	0	0	0	1	0	0	0	0	1	1	0	1	1	0	0	0	0x10F8
R11	0	0	0	0				PLL_F	₹				1	0	0	0	0x18
R12	0	1	0	1	0	0	0	0				PLL	_R_PRE				0x5001
R13	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x4000
R14	0	0	0	1	1	1	1	0	0		CPG		0	0	0	0	0x1E70
R15	0	0	0	0	0	1	1	0	0	1	0	0	1	1	1	1	0x64F
R16	0	0	0	0	0	0	0					VCO_DACI:	SET			•	0x80
R17	0	0	0	0	0	0	0	1	0	0	1	0	1	1	0	0	0x96
R18	0	0	0	0	0	0	0	0	0	1	1	0	0	1	0	0	0x64
R19	0	0	1	0	0	1	1	1				VCO_	CAPCTRL				0x27B7
R20	1	1		VCO_SE	ĒL .	VCO_SEL_ FORCE	0	0	0	1	0	0	1	0	0	0	0x3048
R21	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	1	0x401



DEO								DATA[1	5:0]								Don
REG.	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	POR
R22	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0x1
R23	0	0	0	0	0	0	0	0	0	1	1	1	1	1	0	0	0x7C
R24	0	0	0	0	0	1	1	1	0	0	0	1	1	0	1	0	0x71A
R25	0	0	0	0	0	1	1	0	0	0	1	0	0	1	0	0	0x624
R26	0	0	0	0	1	1	0	1	1	0	1	1	0	0	0	0	0xDB0
R27	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0x2
R28	0	0	0	0	0	1	0	0	1	0	0	0	1	0	0	0	0x488
R29	0	0	1	1	0	0	0	1	1	0	0	0	1	1	0	0	0x318C
R30	0	0	1	1	0	0	0	1	1	0	0	0	1	1	0	0	0x318C
R31	0	SEG1_EN	0	0	0	0	1	1	1	1	1	0	1	1	0	0	0xC3EC
R32	0	0	0	0	0	0	1	1	1	0	0	1	0	0	1	1	0x393
R33	0	0	0	1	1	1	1	0	0	0	1	0	0	0	0	1	0x1E21
R34	0	0	0	0	0	0	0	0	0	0	0	0	0		PLL_N[18:10	6]	0x10
R35	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0x4
R36						•		PLL_N[1	5:0]		•						0x70
R37	1	0			PFD_D	DLY_SEL			0	0	0	0	0	1	0	0	0x205
R38								PLL_DEN[	31:16]								0xFFFF
R39								PLL_DEN	[15:0]								0xFFFF
R40							N	MASH_SEEI	D[31:16]								0x0
R41								MASH_SEE	D[15:0]								0x0
R42								PLL_NUM[	31:16]								0x0
R43								PLL_NUM	[15:0]								0x0
R44	0 0 0 OUTA_PWR OUTB_ OUTA_ MASH_ 0 0 MASH_ORDER										0x22A2						
R45	1	1	0	OL	JTA_MUX	0	0	0	1	1			OUTB_	PWR			0xC622
R46	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1 OUTB_MUX		
R47	0	0	0	0	0	0	1	1	0	0	0	0	0	0	0	0	0x300

28



www.ti.com.cn

								DATA[18	5:0]								202
REG.	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	POR
R48	0	0	0	0	0	0	1	1	0	0	0	0	0	0	0	0	0x3E0
R49	0	1	0	0	0	0	0	1	1	0	0	0	0	0	0	0	0x4180
R50	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x80
R51	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0x80
R52	0	0	0	0	0	1	0	0	0	0	1	0	0	0	0	0	0x420
R53	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R54	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R55	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R56	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R57	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0x0
R58	INPIN_ IGNORE	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0x8001
R59	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	LD_TYPE	0x1
R60		1				1		LD_DL	Y								0x3E8
R61	0	0	0	0	0	0	0	0	1	0	1	0	1	0	0	0	0xA8
R62	0	0	0	0	0	0	1	1	0	0	1	0	0	0	1	0	0xAE
R63	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R64	0	0	0	1	0	0	1	1	1	0	0	0	1	0	0	0	0x1388
R65	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R66	0	0	0	0	0	0	0	1	1	1	1	1	0	1	0	0	0x140
R67	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R68	0	0	0	0	0	0	1	1	1	1	1	0	1	0	0	0	0x3E8
R69		•				•	MAS	H_RST_CO	UNT[31:16]	•	•	•					0x0
R70							MAS	SH_RST_CC	DUNT[15:0]								0xC350
R71	0	0	0	0	0	0 0 SYSREF_DIV_PRE SYSREF_ SYSREF_ O 0						0	0x80				
R72	0	0	0	0	0						SYSREF_	DIV					0x1
R73	0	0	0	0		J	IESD_DAC2_C	TRL					JESD_DAC	C1_CTRL			0x3F



DEG								DATA[18	5:0]								DOD.
REG.	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	POR
R74		SYSREF_PULS	SE_CNT				IESD_DAC4_C	TRL			JESD_DAC3_CTRL				0x0		
R75	0	0	0	0	1			CHDIV			0	0	0	0	0	0	0x800
R76	0	0	0	0	0	0	0	0	0	0	0	0	1	1	0	0	0xC
R77	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R78	0	0	0	0	0	0	0	0	0	1	1	0	0	1	0	0	0x64
R79	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R80	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R81	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R82	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R83	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R84	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R85	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R86	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R87	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R88	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R89	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R90	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R91	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R92	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R93	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R94	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R95	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R96	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R97	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R98	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R99	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R100	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0

30



REG.	DATA[15:0]							POR									
REG.	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	PUR
R101	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R102	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R103	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R104	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R105	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x440
R106	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x7
R107	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R108	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R109	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R110	0	0	0	0	0	rb_LD_	VTUNE	0		rb_VCO_S	EL	0	0	0	0	0	0x0
R111	0	0	0	0	0	0	0	0				rb_VCO	_CAPCTRL				0x0
R112	0	0	0	0	0	0	0					rb_VCO_DAC	CISET				0x0
R113	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0
R114	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0x0

# 表 7-18. Device Registers

Offset	Acronym	Register Name	Section
0x0	R0		Go
0x1	R1		Go
0x2	R2		Go
0x3	R3		Go
0x4	R4		Go
0x5	R5		Go
0x6	R6		Go
0x7	R7		Go
0x8	R8		Go
0x9	R9		Go
0xA	R10		Go



Offset	Acronym	Register Name	Section
0xB	R11		Go
0xC	R12		Go
0xD	R13		Go
0xE	R14		Go
0xF	R15		Go
0x10	R16		Go
0x11	R17		Go
0x12	R18		Go
0x13	R19		Go
0x14	R20		Go
0x15	R21		Go
0x16	R22		Go
0x17	R23		Go
0x18	R24		Go
0x19	R25		Go
0x1A	R26		Go
0x1B	R27		Go
0x1C	R28		Go
0x1D	R29		Go
0x1E	R30		Go
0x1F	R31		Go
0x20	R32		Go
0x21	R33		Go
0x22	R34		Go
0x23	R35		Go
0x24	R36		Go
0x25	R37		Go

0x26         R38         Go           0x27         R39         Go           0x28         R40         Go           0x29         R41         Go           0x2A         R42         Go           0x2B         R43         Go           0x2C         R44         Go           0x2E         R46         Go           0x2F         R47         Go           0x30         R48         Go           0x31         R49         Go           0x32         R50         Go           0x33         R51         Go           0x34         R52         Go           0x35         R53         Go           0x37         R55         Go           0x36         R54         Go           0x37         R55         Go           0x38         R56         Go           0x38         R56         Go           0x38         R59         Go           0x30         R61         Go           0x31         R60         Go           0x32         R50         Go           0x33         R51         Go	Offset	Acronym Register Name	Section
0x28         R40         Go           0x29         R41         Go           0x2A         R42         Go           0x2B         R43         Go           0x2C         R44         Go           0x2D         R45         Go           0x2E         R46         Go           0x31         R49         Go           0x32         R50         Go           0x33         R51         Go           0x34         R52         Go           0x35         R53         Go           0x36         R54         Go           0x37         R55         Go           0x38         R56         Go           0x39         R67         Go           0x30         R69         Go           0x31         R69         Go           0x32         R60         Go           0x33         R67         Go           0x34         R69         Go           0x35         R69         Go           0x36         R60         Go           0x37         R61         Go           0x38         R69         Go	0x26	R38	Go
0x29         R41         Go           0x2A         R42         Go           0x2B         R43         Go           0x2C         R44         Go           0x2D         R45         Go           0x2E         R46         Go           0x32         R48         Go           0x33         R48         Go           0x32         R50         Go           0x33         R51         Go           0x34         R52         Go           0x35         R53         Go           0x36         R54         Go           0x37         R55         Go           0x38         R56         Go           0x38         R56         Go           0x38         R59         Go           0x3B         R59         Go           0x3B         R69         Go           0x3C         R60         Go           0x3E         R62         Go           0x3F         R62         Go	0x27	R39	Go
0x2A         R42         Go           0x2B         R43         Go           0x2C         R44         Go           0x2D         R45         Go           0x2E         R46         Go           0x32         R47         Go           0x33         R48         Go           0x31         R49         Go           0x32         R50         Go           0x33         R51         Go           0x34         R52         Go           0x35         R53         Go           0x36         R54         Go           0x37         R55         Go           0x38         R56         Go           0x38         R56         Go           0x38         R58         Go           0x38         R58         Go           0x38         R58         Go           0x38         R59         Go           0x30         R61         Go	0x28	R40	Go
0x2B         R43         Go           0x2C         R44         Go           0x2D         R45         Go           0x2E         R46         Go           0x2F         R47         Go           0x30         R48         Go           0x31         R49         Go           0x32         R50         Go           0x33         R51         Go           0x34         R52         Go           0x35         R53         Go           0x36         R54         Go           0x37         R55         Go           0x38         R56         Go           0x38         R56         Go           0x33         R58         Go           0x34         R58         Go           0x33         R56         Go           0x34         R56         Go           0x38         R56         Go           0x38         R59         Go           0x38         R59         Go           0x36         R61         Go           0x37         R62         Go           0x38         R62         Go	0x29	R41	Go
0x2C         R44         Go           0x2D         R45         Go           0x2E         R46         Go           0x2F         R47         Go           0x30         R48         Go           0x31         R49         Go           0x32         R50         Go           0x33         R51         Go           0x34         R52         Go           0x35         R53         Go           0x36         R54         Go           0x37         R55         Go           0x38         R56         Go           0x38         R56         Go           0x38         R58         Go           0x3A         R58         Go           0x3B         R59         Go           0x3C         R60         Go           0x3D         R61         Go           0x3F         R62         Go	0x2A	R42	Go
0x2D       R45       Go         0x2E       R46       Go         0x2F       R47       Go         0x30       R48       Go         0x31       R49       Go         0x32       R50       Go         0x33       R51       Go         0x34       R52       Go         0x35       R53       Go         0x36       R54       Go         0x37       R55       Go         0x38       R56       Go         0x39       R57       Go         0x3A       R58       Go         0x3B       R59       Go         0x3C       R60       Go         0x3C       R61       Go         0x3E       R62       Go	0x2B	R43	Go
0XZE       R46       Go         0XZF       R47       Go         0X30       R48       Go         0X31       R49       Go         0X32       R50       Go         0X33       R51       Go         0X34       R52       Go         0X35       R53       Go         0X37       R55       Go         0X38       R56       Go         0X39       R57       Go         0X3A       R58       Go         0X3B       R59       Go         0X3C       R60       Go         0X3D       R61       Go         0X3E       R62       Go         0X3F       R63       Go	0x2C	R44	Go
0x2F       R47       Go         0x30       R48       Go         0x31       R49       Go         0x32       R50       Go         0x33       R51       Go         0x34       R52       Go         0x35       R53       Go         0x37       R55       Go         0x38       R56       Go         0x39       R57       Go         0x3A       R58       Go         0x3B       R59       Go         0x3C       R60       Go         0x3D       R61       Go         0x3E       R62       Go         0x3F       R63       Go	0x2D	R45	Go
0x30       R48       Go         0x31       R49       Go         0x32       R50       Go         0x33       R51       Go         0x34       R52       Go         0x35       R53       Go         0x36       R54       Go         0x37       R55       Go         0x38       R56       Go         0x39       R57       Go         0x3A       R58       Go         0x3B       R59       Go         0x3C       R60       Go         0x3D       R61       Go         0x3E       R62       Go         0x3F       R62       Go	0x2E	R46	Go
0x31       R49       Go         0x32       R50       Go         0x33       R51       Go         0x34       R52       Go         0x35       R53       Go         0x37       R55       Go         0x38       R56       Go         0x39       R57       Go         0x3A       R58       Go         0x3B       R59       Go         0x3C       R60       Go         0x3B       R61       Go         0x3E       R62       Go         0x3F       R63       Go	0x2F	R47	Go
0x32       R50       Go         0x33       R51       Go         0x34       R52       Go         0x35       R53       Go         0x36       R54       Go         0x37       R55       Go         0x38       R56       Go         0x39       R57       Go         0x3A       R58       Go         0x3B       R59       Go         0x3C       R60       Go         0x3D       R61       Go         0x3E       R62       Go         0x3F       R63       Go	0x30	R48	Go
0x33       R51       Go         0x34       R52       Go         0x35       R53       Go         0x36       R54       Go         0x37       R55       Go         0x38       R56       Go         0x39       R57       Go         0x3A       R58       Go         0x3B       R59       Go         0x3C       R60       Go         0x3B       R61       Go         0x3E       R62       Go         0x3F       R63       Go	0x31	R49	Go
0x34       R52         0x35       R53         0x36       R54         0x37       R55         0x38       R56         0x39       R57         0x3A       R58         0x3B       R59         0x3C       R60         0x3D       R61         0x3E       R62         0x3F       R63	0x32	R50	Go
0x35       R53         0x36       R54         0x37       R55         0x38       R56         0x39       R57         0x3A       R58         0x3B       R59         0x3C       R60         0x3B       R59         0x3C       R60         0x3B       R59         0x3C       R60         0x3B       R61         0x3B       R62         0x3F       R63	0x33	R51	Go
0x36       R54       Go         0x37       R55       Go         0x38       R56       Go         0x39       R57       Go         0x3A       R58       Go         0x3B       R59       Go         0x3C       R60       Go         0x3B       R61       Go         0x3E       R62       Go         0x3F       R63       Go	0x34	R52	Go
0x37       R55       Go         0x38       R56       Go         0x39       R57       Go         0x3A       R58       Go         0x3B       R59       Go         0x3C       R60       Go         0x3D       R61       Go         0x3E       R62       Go         0x3F       R63       Go	0x35	R53	Go
0x38       R56       Go         0x39       R57       Go         0x3A       R58       Go         0x3B       R59       Go         0x3C       R60       Go         0x3D       R61       Go         0x3E       R62       Go         0x3F       R63       Go	0x36	R54	Go
0x39       R57         0x3A       R58         0x3B       R59         0x3C       R60         0x3D       R61         0x3E       R62         0x3F       R63	0x37	R55	Go
0x3A       R58         0x3B       R59         0x3C       R60         0x3D       R61         0x3E       R62         0x3F       R63	0x38	R56	Go
0x3B       R59         0x3C       R60         0x3D       R61         0x3E       R62         0x3F       R63	0x39	R57	Go
0x3C       R60         0x3D       R61         0x3E       R62         0x3F       R63             Go         Go         Go	0x3A	R58	Go
0x3D       R61         0x3E       R62         0x3F       R63         Go       Go	0x3B	R59	Go
0x3E       R62         0x3F       R63         Go       Go	0x3C	R60	Go
0x3F R63 Go	0x3D	R61	Go
	0x3E	R62	Go
0x40 R64 Go	0x3F	R63	Go
	0x40	R64	Go



0x41         R65         Go           0x42         R66         Go           0x43         R67         Go           0x44         R88         Go           0x45         R69         Go           0x46         R70         Go           0x47         R71         Go           0x48         R72         Go           0x48         R73         Go           0x48         R74         Go           0x42         R76         Go           0x42         R76         Go           0x42         R76         Go           0x42         R78         Go           0x42         R78         Go           0x42         R78         Go           0x43         R80         Go           0x44         R80         Go           0x45         R80         Go           0x50         R80         Go           0x51         R81         Go           0x52         R82         Go           0x53         R83         Go           0x54         R84         Go           0x55         R86         Go	Offset	Acronym Register Name	Section
0x43         R67         Go           0x44         R88         Go           0x45         R69         Go           0x46         R70         Go           0x47         R71         Go           0x48         R72         Go           0x48         R73         Go           0x48         R74         Go           0x48         R75         Go           0x40         R76         Go           0x40         R77         Go           0x41         R78         Go           0x42         R78         Go           0x45         R79         Go           0x50         R80         Go           0x51         R81         Go           0x52         R82         Go           0x53         R83         Go           0x55         R85         Go           0x56         R86         Go           0x57         R87         Go           0x58         R88         Go           0x59         R89         Go           0x58         R89         Go	0x41	R65	Go
0x44         R68         Go           0x45         R69         Go           0x46         R70         Go           0x47         R71         Go           0x48         R72         Go           0x49         R73         Go           0x40         R76         Go           0x41         R76         Go           0x42         R76         Go           0x42         R78         Go           0x42         R78         Go           0x42         R78         Go           0x43         R80         Go           0x50         R80         Go           0x51         R81         Go           0x52         R82         Go           0x53         R83         Go           0x54         R84         Go           0x55         R85         Go           0x56         R86         Go           0x57         R87         Go           0x58         R88         Go           0x59         R89         Go	0x42	R66	Go
0x45         R69         Go           0x46         R70         Go           0x47         R71         Go           0x48         R72         Go           0x49         R73         Go           0x4A         R74         Go           0x4C         R76         Go           0x4D         R77         Go           0x4E         R78         Go           0x50         R80         Go           0x51         R81         Go           0x52         R82         Go           0x53         R83         Go           0x55         R85         Go           0x55         R85         Go           0x56         R86         Go           0x57         R87         Go           0x58         R86         Go           0x59         R89         Go           0x59         R89         Go           0x58         R89         Go           0x58         R89         Go	0x43	R67	Go
0x46       R70       Go         0x47       R71       Go         0x48       R72       Go         0x49       R73       Go         0x4A       R74       Go         0x4B       R75       Go         0x4C       R76       Go         0x4D       R77       Go         0x4E       R78       Go         0x50       R80       Go         0x51       R81       Go         0x52       R82       Go         0x53       R83       Go         0x55       R85       Go         0x55       R86       Go         0x55       R86       Go         0x56       R86       Go         0x58       R88       Go         0x58       R88       Go         0x58       R89       Go	0x44	R68	Go
0x47         R71         Go           0x48         R72         Go           0x49         R73         Go           0x4A         R74         Go           0x4B         R75         Go           0x4C         R76         Go           0x4D         R77         Go           0x4E         R78         Go           0x4F         R79         Go           0x50         R80         Go           0x51         R81         Go           0x52         R82         Go           0x53         R83         Go           0x54         R84         Go           0x55         R85         Go           0x56         R86         Go           0x57         R87         Go           0x58         R88         Go           0x58         R88         Go           0x58         R89         Go           0x5A         R90         Go	0x45	R69	Go
0x48       R72       Go         0x49       R73       Go         0x4A       R74       Go         0x4B       R75       Go         0x4C       R76       Go         0x4D       R77       Go         0x4E       R78       Go         0x4F       R79       Go         0x50       R80       Go         0x51       R81       Go         0x52       R82       Go         0x53       R83       Go         0x54       R84       Go         0x55       R85       Go         0x56       R86       Go         0x57       R87       Go         0x58       R88       Go         0x59       R89       Go         0x5A       R90       Go	0x46	R70	Go
0x49       R73       Go         0x4A       R74       Go         0x4B       R75       Go         0x4C       R76       Go         0x4D       R77       Go         0x4E       R78       Go         0x4F       R79       Go         0x50       R80       Go         0x51       R81       Go         0x52       R82       Go         0x53       R83       Go         0x54       R84       Go         0x55       R85       Go         0x56       R86       Go         0x57       R87       Go         0x58       R88       Go         0x59       R89       Go         0x5A       R90       Go	0x47	R71	Go
0x4A       R74       Go         0x4B       R75       Go         0x4C       R76       Go         0x4D       R77       Go         0x4E       R78       Go         0x4F       R79       Go         0x50       R80       Go         0x51       R81       Go         0x52       R82       Go         0x53       R83       Go         0x54       R84       Go         0x55       R85       Go         0x56       R86       Go         0x57       R87       Go         0x58       R88       Go         0x59       R89       Go         0x5A       R90       Go	0x48	R72	Go
0x4B       R75       Go         0x4C       R76       Go         0x4D       R77       Go         0x4E       R78       Go         0x4F       R79       Go         0x50       R80       Go         0x51       R81       Go         0x52       R82       Go         0x53       R83       Go         0x54       R84       Go         0x55       R85       Go         0x56       R86       Go         0x57       R87       Go         0x58       R88       Go         0x59       R89       Go         0x5A       R90       Go	0x49	R73	Go
0x4C       R76       Go         0x4D       R77       Go         0x4E       R78       Go         0x4F       R79       Go         0x50       R80       Go         0x51       R81       Go         0x52       R82       Go         0x53       R83       Go         0x54       R84       Go         0x55       R85       Go         0x56       R86       Go         0x57       R87       Go         0x58       R88       Go         0x59       R89       Go         0x5A       R90       Go	0x4A	R74	Go
0x4D       R77         0x4E       R78         0x4F       R79         0x50       R80         0x51       R81         0x52       R82         0x53       R83         0x54       R84         0x55       R85         0x56       R86         0x57       R87         0x58       R88         0x59       R89         0x50       G0         0x54       R89	0x4B	R75	Go
0x4E       R78       Go         0x4F       R79       Go         0x50       R80       Go         0x51       R81       Go         0x52       R82       Go         0x53       R83       Go         0x54       R84       Go         0x55       R85       Go         0x56       R86       Go         0x57       R87       Go         0x58       R88       Go         0x59       R89       Go         0x5A       R90       Go	0x4C	R76	Go
0x4F       R79         0x50       R80       Go         0x51       R81       Go         0x52       R82       Go         0x53       R83       Go         0x54       R84       Go         0x55       R85       Go         0x56       R86       Go         0x57       R87       Go         0x58       R88       Go         0x59       R89       Go         0x5A       R90       Go	0x4D	R77	Go
0x50       R80         0x51       R81         0x52       R82         0x53       R83         0x54       R84         0x55       R85         0x56       R86         0x57       R87         0x58       R88         0x59       R89         0x5A       R90	0x4E	R78	Go
0x51       R81       Go         0x52       R82       Go         0x53       R83       Go         0x54       R84       Go         0x55       R85       Go         0x56       R86       Go         0x57       R87       Go         0x58       R88       Go         0x59       R89       Go         0x5A       R90       Go	0x4F	R79	Go
0x52       R82       Go         0x53       R83       Go         0x54       R84       Go         0x55       R85       Go         0x56       R86       Go         0x57       R87       Go         0x58       R88       Go         0x59       R89       Go         0x5A       R90       Go	0x50	R80	Go
0x53       R83       Go         0x54       R84       Go         0x55       R85       Go         0x56       R86       Go         0x57       R87       Go         0x58       R88       Go         0x59       R89       Go         0x5A       R90       Go	0x51	R81	Go
0x54       R84         0x55       R85         0x56       R86         0x57       R87         0x58       R88         0x59       R89         0x5A       R90	0x52	R82	Go
0x55       R85         0x56       R86         0x57       R87         0x58       R88         0x59       R89         0x5A       R90	0x53	R83	Go
0x56       R86         0x57       R87         0x58       R88         0x59       R89         0x5A       R90	0x54	R84	Go
0x57       R87         0x58       R88         0x59       R89         0x5A       R90             Go         Go         Go	0x55	R85	Go
0x58       R88         0x59       R89         0x5A       R90             Go         Go	0x56	R86	Go
0x59       R89       Go         0x5A       R90       Go	0x57	R87	Go
0x5A R90 Go	0x58	R88	Go
	0x59	R89	Go
0x5B R91 Go	0x5A	R90	Go
	0x5B	R91	Go

Offset	Acronym	Register Name	Section
0x5C	R92		Go
0x5D	R93		Go
0x5E	R94		Go
0x5F	R95		Go
0x60	R96		Go
0x61	R97		Go
0x62	R98		Go
0x63	R99		Go
0x64	R100		Go
0x65	R101		Go
0x66	R102		Go
0x67	R103		Go
0x68	R104		Go
0x69	R105		Go
0x6A	R106		Go
0x6B	R107		Go
0x6C	R108		Go
0x6D	R109		Go
0x6E	R110		Go
0x6F	R111		Go
0x70	R112		Go
0x71	R113		Go
0x72	R114		Go

Complex bit access types are encoded to fit into small table cells. 表 7-19 shows the codes that are used for access types in this section.

# 表 7-19. Device Access Type Codes

72 1 101 201100 7 100000 1 Jpo Couloo						
Access Type	Code	Description				
Read Type						



# 表 7-19. Device Access Type Codes (continued)

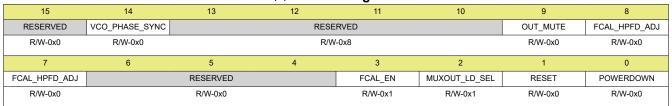
Access Type	Code	Description			
R	R	Read			
Write Type	Write Type				
W	W	Write			
Reset or Default Value					
-n		Value after reset or the default value			

# 7.6.1 R0 Register (Offset = 0x0) [reset = 0x200C]

R0 is shown in  $\boxtimes$  7-10 and described in  $\gtrless$  7-20.

Return to 表 7-18.

# 图 7-10. R0 Register



# 表 7-20. R0 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	RESERVED	R/W	0x0	Program 0x0 to this field.
14	VCO_PHASE_SYNC	R/W	0x0	Enables phase SYNC. In this state, part of the channel divider is put in the feedback path to ensure deterministic phase. The action of toggling this bit from 0 to 1 also sends an asynchronous SYNC pulse.  0x0 = Normal operation  0x1 = Phase SYNC enabled
13-10	RESERVED	R/W	0x8	Program 0x8 to this field.
9	OUT_MUTE	R/W	0x0	Mute the outputs (RFOUTA / RFOUTB) when the VCO is calibrating.  0x0 = Disabled  0x1 = Muted
8-7	FCAL_HPFD_ADJ	R/W	0x0	Set this field in accordance to the phase detector frequency for optimal VCO calibration. $0x0 = f_{PD} \leqslant 100 \text{ MHz}$ $0x1 = 100 \text{ MHz} < f_{PD} \leqslant 150 \text{ MHz}$ $0x2 = 150 \text{ MHz} < f_{PD} \leqslant 200 \text{ MHz}$ $0x3 = f_{PD} > 200 \text{ MHz}$
6-4	RESERVED	R/W	0x0	Program 0x1 to this field.
3	FCAL_EN	R/W	0x1	Writing register R0 with this bit set to a '1' enables and triggers the VCO frequency calibration.  0x0 = No VCO frequency calibration  0x1 = Enabled
2	MUXOUT_LD_SEL	R/W	0x1	Selects the functionality of the MUXOUT pin.  0x0 = Register readback  0x1 = Lock detect
1	RESET	R/W	0x0	Register reset. This resets all registers and state machines. After writing a '1', you must write a '0' to remove the reset. It is recommended to toggle the RESET bit before programming the part to ensure consistent performance.  0x0 = Normal operation  0x1 = Reset
0	POWERDOWN	R/W	0x0	Powers down device.  0x0 = Normal operation  0x1 = Powered down

# 7.6.2 R1 Register (Offset = 0x1) [reset = 0x80C]

R1 is shown in 图 7-11 and described in 表 7-21.

Return to 表 7-18.



# 图 7-11. R1 Register

15	14	13	12	11	10	9	8			
RESERVED										
R/W-0x80										
7	6	5	4	3	2	1	0			
	RESE	RVED		MUXOUT_CTRL	CAL_CLK_DIV					
	R/W-	0x80		R/W-0x1		R/W-0x4				

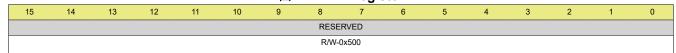
# 表 7-21. R1 Register Field Descriptions

Bit	Field	Туре	Reset	Description	
15-4	RESERVED	R/W	0x80	Program 0x80 to this field.	
3	MUXOUT_CTRL	R/W	0x1	Sets the MUXOUT pin status.  0x0 = Tri-state  0x1 = Normal operation	
2-0	CAL_CLK_DIV	R/W	0x4	Divides down the $f_{OSC}$ frequency to the state machine clock frequency. $f_{SM} = f_{OSC} / (2^{CAL\_CLK\_DIV})$ . Ensure that the state machine clock frequency is 50 MHz or less. $0x0 = f_{OSC} \leqslant 50$ MHz $0x1 = 50$	

# 7.6.3 R2 Register (Offset = 0x2) [reset = 0x500]

Return to 表 7-18.

# 图 7-12. R2 Register



#### 表 7-22. R2 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x500	Program 0x500 to this field.

# 7.6.4 R3 Register (Offset = 0x3) [reset = 0x642]

R3 is shown in 图 7-13 and described in 表 7-23.

Return to 表 7-18.

# 图 7-13. R3 Register



#### 表 7-23. R3 Register Field Descriptions

	Bit	Field	Туре	Reset	Description
Ī	15-0	RESERVED	R/W	0x642	Program 0x642 to this field.

#### 7.6.5 R4 Register (Offset = 0x4) [reset = 0xA43]

R4 is shown in 图 7-14 and described in 表 7-24.

Return to 表 7-18.

#### 图 7-14. R4 Register



# 表 7-24. R4 Register Field Descriptions

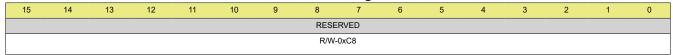
Bit	Bit Field Ty		Reset	Description
15-0	RESERVED	R/W	0xA43	Program 0xE43 to this field.

## 7.6.6 R5 Register (Offset = 0x5) [reset = 0xC8]

R5 is shown in 图 7-15 and described in 表 7-25.

Return to 表 7-18.

#### 图 7-15. R5 Register



# 表 7-25. R5 Register Field Descriptions

Bit	Field	Type Reset		Description
15-0	RESERVED	R/W	0xC8	Program 0x3E8 to this field.

## 7.6.7 R6 Register (Offset = 0x6) [reset = 0xC802]

R6 is shown in  $\boxtimes$  7-16 and described in 表 7-26.

Return to 表 7-18.

#### 图 7-16. R6 Register



### 表 7-26. R6 Register Field Descriptions

Bit	Field	ield Type Reset		Description		
15-0	RESERVED	R/W	0xC802	Program 0x7802 to this field.		

# 7.6.8 R7 Register (Offset = 0x7) [reset = 0xB2]

R7 is shown in  $\boxtimes$  7-17 and described in ₹ 7-27.

Return to 表 7-18.

# 图 7-17. R7 Register

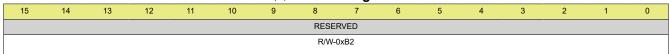




表 7-27. R7 Register Field Descriptions

Bit	Field	Id Type Reset		Description
15-0	RESERVED	R/W	0xB2	Program 0xB2 to this field.

# 7.6.9 R8 Register (Offset = 0x8) [reset = 0x2000]

Return to 表 7-18.

# 图 7-18. R8 Register

15	14	13	12	11	10	9	8		
RESERVED	VCO_DACISET_FO RCE	RESERV	ED	VCO_CAPCTRL_FO RCE		RESERVED			
R/W-0x0	R/W-0x0	R/W-0x	R/W-0x2		R/W-0x0				
7	6	5	4	3	2	1	0		
	RESERVED								
	R/W-0x0								

# 表 7-28. R8 Register Field Descriptions

Bit	Field	Туре	Reset	Description	
15	RESERVED	R/W	0x0	Program 0x0 to this field.	
14	VCO_DACISET_FORCE	R/W	0x0	Forces VCO_DACISET value. Useful for fully assisted VCO calibration and debugging purposes.  0x0 = Normal operation  0x1 = Use VCO_DACISET value instead of the value obtained to VCO calibration	
13-12	RESERVED	R/W	0x2	Program 0x2 to this field.	
11	VCO_CAPCTRL_FORCE	R/W	0x0	Forces VCO_CAPCTRL value. Useful for fully assisted VCO calibration and debugging purposes.  0x0 = Normal operation  0x1 = Use VCO_CAPCTRL value instead of the value obtained from VCO calibration	
10-0	RESERVED	R/W	0x0	Program 0x0 to this field.	

# 7.6.10 R9 Register (Offset = 0x9) [reset = 0x604]

R9 is shown in 图 7-19 and described in 表 7-29.

Return to 表 7-18.

# 图 7-19. R9 Register

15	14	13	12	11	10	9	8
RESERVED			OSC_2X		RESEF	RVED	
R/W-0x0			R/W-0x0	R/W-0x604			
7	6	5	4	3	2	1	0
			RESE	RVED			
R/W-0x604							

# 表 7-29. R9 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-13	RESERVED	R/W	0x0 Program 0x0 to this field.	
12	OSC_2X	R/W	0x0	Enables OSCIN doubler.  0x0 = Disabled  0x1 = Enable

表 7-29. R9 Register Field Descriptions (continued)

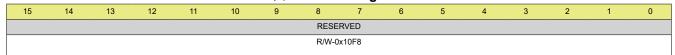
Bit	Field	Туре	Reset	Description
11-0	RESERVED	R/W	0x604	Program 0x604 to this field.

# 7.6.11 R10 Register (Offset = 0xA) [reset = 0x10F8]

R10 is shown in 图 7-20 and described in 表 7-30.

Return to 表 7-18.

#### 图 7-20. R10 Register



#### 表 7-30. R10 Register Field Descriptions

Bit	Field	Туре	Reset	Description	
15-0	RESERVED	R/W	0x10F8	Program 0x10D8 to this field.	

# 7.6.12 R11 Register (Offset = 0xB) [reset = 0x18]

R11 is shown in 图 7-21 and described in 表 7-31.

Return to 表 7-18.

# 图 7-21. R11 Register

				рц . =	i togioto.			
	15	14	13	12	11	10	9	8
		RESE	RVED			PLL	_R	
		R/W	-0x0	·	R/W-0x1			
	7	6	5	4	3	2	1	0
		PLL	_R			RESE	RVED	
Г		R/W	-0x1			R/W-	-0x8	
- 1								

# 表 7-31. R11 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-12	RESERVED	R/W	0x0	Program 0x0 to this field.
11-4	PLL_R	R/W	0x1	PLL Post-R divider value.
3-0	RESERVED	R/W	0x8	Program 0x8 to this field.

# 7.6.13 R12 Register (Offset = 0xC) [reset = 0x5001]

R12 is shown in 图 7-22 and described in 表 7-32.

Return to 表 7-18.

## 图 7-22. R12 Register

				- 3					
15	14	13	12	11	10	9	8		
RESERVED									
R/W-0x50									
7	6	5	4	3	2	1	0		
			PLL_F	R_PRE					
			R/W	-0x1					

# 表 7-32. R12 Register Field Descriptions

_					<u> </u>
	Bit	Field	Туре	Reset	Description
	15-8	RESERVED	R/W	0x50	Program 0x50 to this field.



表 7-32. R12 Register Field Descriptions (continued)

Bit	Field	Туре	Reset	Description		
7-0	PLL_R_PRE	R/W	0x1	PLL Pre-R divider value.		

# 7.6.14 R13 Register (Offset = 0xD) [reset = 0x4000]

R13 is shown in 图 7-23 and described in 表 7-33.

Return to 表 7-18.

### 图 7-23. R13 Register



#### 表 7-33. R13 Register Field Descriptions

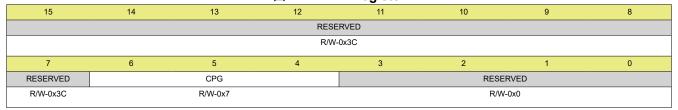
Bit	Field	Туре	Reset	Description	
15-0	RESERVED	R/W	0x4000	Program 0x4000 to this field.	

# 7.6.15 R14 Register (Offset = 0xE) [reset = 0x1E70]

R14 is shown in 图 7-24 and described in 表 7-34.

Return to 表 7-18.

# 图 7-24. R14 Register



# 表 7-34. R14 Register Field Descriptions

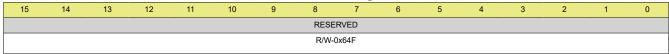
Bit	Field	Туре	Reset	Description
15-7	RESERVED	R/W	0x3C	Program 0x3C to this field.
6-4	CPG	R/W	0x7	Effective charge pump gain. This is the sum of the up and down currents.  0x0 = Tri-state  0x4 = 3 mA  0x1 = 6 mA  0x5 = 9 mA  0x3 = 12 mA  0x7 = 15 mA  All other values are not used.
3-0	RESERVED	R/W	0x0	Program 0x0 to this field.

# 7.6.16 R15 Register (Offset = 0xF) [reset = 0x64F]

R15 is shown in 图 7-25 and described in 表 7-35.

Return to 表 7-18.

#### 图 7-25. R15 Register



Submit Document Feedback

表 7-35. R15 Register Field Descriptions

Bit Field		Туре	Reset	Description		
15-0	RESERVED	R/W	0x64F	Program 0x64F to this field.		

### 7.6.17 R16 Register (Offset = 0x10) [reset = 0x80]

R16 is shown in 图 7-26 and described in 表 7-36.

Return to 表 7-18.

#### 图 7-26. R16 Register

15	14	13	12	11	10	9	8		
	RESERVED								
	R/W-0x0								
7	6	5	4	3	2	1	0		
-	<del> </del>		VCO DA	CISET		<u> </u>	-		
VCO_DACISET									
			R/W-0	08x0					

#### 表 7-36. R16 Register Field Descriptions

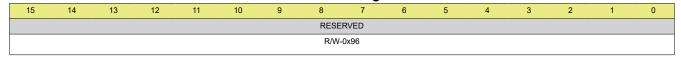
Bit	Bit Field Type Re		Reset	Description
15-9	RESERVED	R/W	0x0	Program 0x0 to this field.
8-0	VCO_DACISET	R/W	0x80	Programmable current setting for the VCO that is applied when VCO_DACISET_FORCE = 1. Useful for fully-assisted VCO calibration.

## 7.6.18 R17 Register (Offset = 0x11) [reset = 0x96]

R17 is shown in 图 7-27 and described in 表 7-37.

Return to 表 7-18.

# 图 7-27. R17 Register



#### 表 7-37. R17 Register Field Descriptions

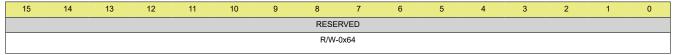
	Bit	Field	Туре	Reset	Description
Γ	15-0	RESERVED	R/W	0x96	Program 0x12C to this field.

#### 7.6.19 R18 Register (Offset = 0x12) [reset = 0x64]

R18 is shown in 图 7-28 and described in 表 7-38.

Return to 表 7-18.

# 图 7-28. R18 Register



#### 表 7-38. R18 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x64	Program 0x64 to this field.

# 7.6.20 R19 Register (Offset = 0x13) [reset = 0x27B7]

R19 is shown in 图 7-29 and described in 表 7-39.



Return to 表 7-18.

# 图 7-29. R19 Register

15	14	13	12	11	10	9	8		
RESERVED									
R/W-0x27									
7	6	5	4	3	2	1	0		
VCO_CAPCTRL									
R/W-0xB7									

# 表 7-39. R19 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-8	RESERVED	R/W 0x27		Program 0x27 to this field.
7-0	VCO_CAPCTRL	R/W		Programmable band within VCO core that applies when VCO_CAPCTRL_FORCE = 1. Valid values are 183 to 0, where the higher number is a lower frequency.

# 7.6.21 R20 Register (Offset = 0x14) [reset = 0x3048]

R20 is shown in 图 7-30 and described in 表 7-40.

Return to 表 7-18.

# 图 7-30. R20 Register

15	14	13	12	11	10	9	8		
RESE	RVED		VCO_SEL		VCO_SEL_FORCE	RVED			
R/W	/-0x0		R/W-0x6		R/W-0x0	R/W-0x0 R/W-0x48			
7	6	5 4 3			2	1	0		
	RESERVED								
	R/W-0x48								

# 表 7-40. R20 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-14	RESERVED	R/W	0x0	Program 0x3 to this field.
13-11	VCO_SEL	R/W	0x6	User specified start VCO for calibration. Also is the VCO core that is forced by VCO_SEL_FORCE.  0x1 = VCO1  0x2 = VCO2   0x7 = VCO7
10	VCO_SEL_FORCE	R/W	0x0	Forces the VCO to use the core specified by VCO_SEL.  0x0 = Disabled  0x1 = Enable
9-0	RESERVED	R/W	0x48	Program 0x48 to this field.

# 7.6.22 R21 Register (Offset = 0x15) [reset = 0x401]

R21 is shown in 图 7-31 and described in 表 7-41.

Return to 表 7-18.

# 图 7-31. R21 Register

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	RESERVED														
	R/W-0x401														

Product Folder Links: LMX2694-EP

表 7-41. R21 Register Field Descriptions

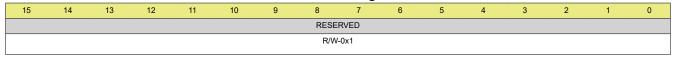
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x401	Program 0x401 to this field.

### 7.6.23 R22 Register (Offset = 0x16) [reset = 0x1]

R22 is shown in 图 7-32 and described in 表 7-42.

Return to 表 7-18.

### 图 7-32. R22 Register



#### 表 7-42. R22 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x1	Program 0x1 to this field

# 7.6.24 R23 Register (Offset = 0x17) [reset = 0x7C]

R23 is shown in 图 7-33 and described in 表 7-43.

Return to 表 7-18.

### 图 7-33. R23 Register



#### 表 7-43. R23 Register Field Descriptions

		• .		• • • • • • • • • • • • • • • • • • •
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x7C	Program 0x7C to this field.

#### 7.6.25 R24 Register (Offset = 0x18) [reset = 0x71A]

R24 is shown in 图 7-34 and described in 表 7-44.

Return to 表 7-18.

#### 图 7-34. R24 Register



# 表 7-44. R24 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x71A	Program 0x71A to this field.

# 7.6.26 R25 Register (Offset = 0x19) [reset = 0x624]

R25 is shown in 图 7-35 and described in 表 7-45.

Return to 表 7-18.

#### 图 7-35. R25 Register





### 图 7-35. R25 Register (continued)

R/W-0x624

### 表 7-45. R25 Register Field Descriptions

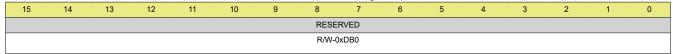
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x624	Program 0x624 to this field.

#### 7.6.27 R26 Register (Offset = 0x1A) [reset = 0xDB0]

R26 is shown in 图 7-36 and described in 表 7-46.

Return to 表 7-18.

# 图 7-36. R26 Register



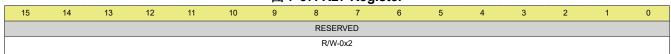
#### 表 7-46. R26 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0xDB0	Program 0xDB0 to this field.

#### 7.6.28 R27 Register (Offset = 0x1B) [reset = 0x2]

Return to 表 7-18.

## 图 7-37. R27 Register



#### 表 7-47. R27 Register Field Descriptions

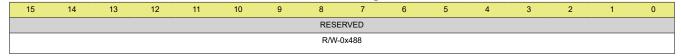
		• .	•	•
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x2	Program 0x2 to this field.

#### 7.6.29 R28 Register (Offset = 0x1C) [reset = 0x488]

R28 is shown in 图 7-38 and described in 表 7-48.

Return to 表 7-18.

#### 图 7-38. R28 Register



#### 表 7-48. R28 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x488	Program 0x488 to this field.

# 7.6.30 R29 Register (Offset = 0x1D) [reset = 0x318C]

R29 is shown in 图 7-39 and described in 表 7-49.

Return to 表 7-18.

#### 图 7-39. R29 Register

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RESERVED															
							R/W-0	)x318C							

### 表 7-49. R29 Register Field Descriptions

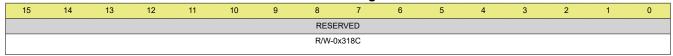
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x318C	Program 0x318C to this field.

# 7.6.31 R30 Register (Offset = 0x1E) [reset = 0x318C]

R30 is shown in 图 7-40 and described in 表 7-50.

Return to 表 7-18.

#### 图 7-40. R30 Register



### 表 7-50. R30 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x318C	Program 0x318C to this field.

# 7.6.32 R31 Register (Offset = 0x1F) [reset = 0xC3EC]

R31 is shown in 图 7-41 and described in 表 7-51.

Return to 表 7-18.

#### 图 7-41. R31 Register

				- 9			
15	14	13	12	11	10	9	8
RESERVED	SEG1_EN			RESE	RVED		
R/W-0x1	R/W-0x1			R/W-0	)x3EC		
7	6	5	4	3	2	1	0
	RESERVED						
			R/W-0	x3EC			

#### 表 7-51. R31 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	RESERVED	R/W	0x1	Program 0x0 to this field.
14	SEG1_EN	R/W		Enables the first divide-by-2 in channel divider.  0x0 = Disabled  0x1 = Enable
13-0	RESERVED	R/W	0x3EC	Program 0x3EC to this field.

# 7.6.33 R32 Register (Offset = 0x20) [reset = 0x393]

R32 is shown in 图 7-42 and described in 表 7-52.

Return to 表 7-18.

#### 图 7-42. R32 Register





表 7-52. R32 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x393	Program 0x393 to this field.

#### 7.6.34 R33 Register (Offset = 0x21) [reset = 0x1E21]

R33 is shown in 图 7-43 and described in 表 7-53.

Return to 表 7-18.

#### 图 7-43. R33 Register



#### 表 7-53. R33 Register Field Descriptions

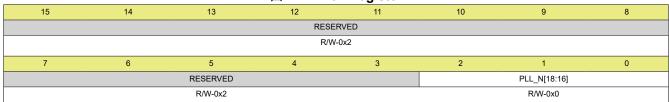
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x1E21	Program 0x1E21 to this field.

#### 7.6.35 R34 Register (Offset = 0x22) [reset = 0x10]

R34 is shown in 图 7-44 and described in 表 7-54.

Return to 表 7-18.

### 图 7-44. R34 Register



### 表 7-54. R34 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-3	RESERVED	R/W	0x2	Program 0x0 to this field.
2-0	PLL_N[18:16]	R/W	0x0	Upper 3 bits of N divider, total 19 bits, split as 16 + 3.

# 7.6.36 R35 Register (Offset = 0x23) [reset = 0x4]

R35 is shown in 图 7-45 and described in 表 7-55.

Return to 表 7-18.

#### 图 7-45. R35 Register

15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0  RESERVED												0		
								RESE	RVED					
								R/W	/-0x4					

#### 表 7-55. R35 Register Field Descriptions

				<u> </u>
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x4	Program 0x4 to this field.

# 7.6.37 R36 Register (Offset = 0x24) [reset = 0x70]

R36 is shown in 图 7-46 and described in 表 7-56.

Return to 表 7-18.

#### 图 7-46. R36 Register

15	15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0														
	PLL_N[15:0]														
	R/W-0x70														

# 表 7-56. R36 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	PLL_N[15:0]	R/W	0x70	Lower 16 bits of N divider.

# 7.6.38 R37 Register (Offset = 0x25) [reset = 0x205]

R37 is shown in 图 7-47 and described in 表 7-57.

Return to 表 7-18.

#### 图 7-47. R37 Register

15	14	13	12	11	10	9	8		
RESEI	RVED			PFD_D	LY_SEL				
R/W-	-0x0	R/W-0x2							
7	6	5	4	3	2	1	0		
	RESERVED								
			R/W	'-0x5					

# 表 7-57. R37 Register Field Descriptions

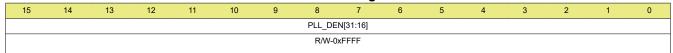
Bit	Field	Туре	Reset	Description
15-14 RESERVED R 13-8 PFD_DLY_SEL R		R/W	0x0	Program 0x2 to this field.
13-8	PFD_DLY_SEL	R/W	0x2	Programmable phase detector delay. This should be programmed based on VCO frequency, fractional order, and N divider value. See 表 7-2 for details.
7-0	RESERVED	R/W	0x5	Program 0x4 to this field.

# 7.6.39 R38 Register (Offset = 0x26) [reset = 0xFFFF]

R38 is shown in 图 7-48 and described in 表 7-58.

Return to 表 7-18.

#### 图 7-48. R38 Register



# 表 7-58. R38 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	PLL_DEN[31:16]	R/W	0xFFFF	Upper 16 bits of fractional denominator (DEN).

# 7.6.40 R39 Register (Offset = 0x27) [reset = 0xFFFF]

R39 is shown in 图 7-49 and described in 表 7-59.

Return to 表 7-18.

#### 图 7-49. R39 Register

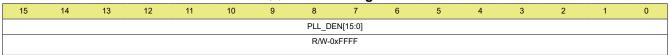




表 7-59. R39 Register Field Descriptions

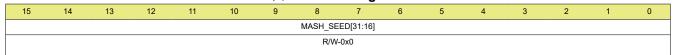
Bit	Field	Туре	Reset	Description
15-0	PLL_DEN[15:0]	R/W	0xFFFF	Lower 16 bits of fractional denominator (DEN).

#### 7.6.41 R40 Register (Offset = 0x28) [reset = 0x0]

R40 is shown in 图 7-50 and described in 表 7-60.

Return to 表 7-18.

### 图 7-50. R40 Register



#### 表 7-60. R40 Register Field Descriptions

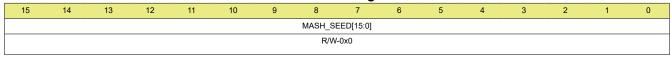
Bit	Field	the fractional	Description	
15-0	MASH_SEED[31:16]	R/W		Upper 16 bits of MASH_SEED. MASH_SEED sets the initial state of the fractional engine. Useful for producing a phase shift and fractional spur optimization.

# 7.6.42 R41 Register (Offset = 0x29) [reset = 0x0]

R41 is shown in 图 7-51 and described in 表 7-61.

Return to 表 7-18.

#### 图 7-51. R41 Register



#### 表 7-61. R41 Register Field Descriptions

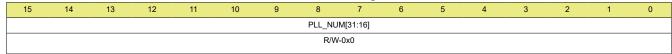
Bit	Field	Туре	Reset	Description
15-0	MASH_SEED[15:0]	R/W		Lower 16 bits of MASH_SEED. MASH_SEED sets the initial state of the fractional engine. Useful for producing a phase shift and fractional spur optimization.

#### 7.6.43 R42 Register (Offset = 0x2A) [reset = 0x0]

R42 is shown in 图 7-52 and described in 表 7-62.

Return to 表 7-18.

#### 图 7-52. R42 Register



# 表 7-62. R42 Register Field Descriptions

Bit	Field	Type Reset Description		Description
15-0	PLL_NUM[31:16]	R/W	0x0	Upper 16 bits of fractional numerator (NUM).

#### 7.6.44 R43 Register (Offset = 0x2B) [reset = 0x0]

R43 is shown in 图 7-53 and described in 表 7-63.

Return to 表 7-18.

# 图 7-53. R43 Register

15													0		
PLL_NUM[15:0]															
	R/W-0x0														

# 表 7-63. R43 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	PLL_NUM[15:0]	R/W	0x0	Lower 16 bits of fractional numerator (NUM).

# 7.6.45 R44 Register (Offset = 0x2C) [reset = 0x22A2]

R44 is shown in 图 7-54 and described in 表 7-64.

Return to 表 7-18.

# 图 7-54. R44 Register

15	14	13	12	11	10	9	8
RESE	RVED			OUTA	_PWR		
R/W	V-0x0			R/W-	0x22		
7	6	5	4	3	2	1	0
OUTB_PD	OUTA_PD	MASH_RESET_N	RESERVED		MASH_ORDER		
R/W-0x1	R/W-0x0	R/W-0x1	R/W-0x0 R/W-0x2				

# 表 7-64. R44 Register Field Descriptions

<b>D</b> 14				n : "
Bit	Field	Туре	Reset	Description
15-14	RESERVED	R/W	0x0	Program 0x0 to this field.
13-8	OUTA_PWR	R/W	0x22	Sets current that controls output power for RFOUTA. 0x0 is minimum current; 0x1F is maximum current.
7	OUTB_PD	R/W	0x1	Powers down RFOUTB.  0x0 = Normal operation  0x1 = Powered down
6	OUTA_PD	R/W	0x0	Powers down RFOUTA.  0x0 = Normal operation  0x1 = Powered down
5	MASH_RESET_N	R/W	0x1	Resets MASH.  0x0 = Reset  0x1 = Normal operation
4-3	RESERVED	R/W	0x0	Program 0x0 to this field.
2-0	MASH_ORDER	R/W	0x2	Sets the MASH order. 0x0: Integer mode 0x1: First order modulator 0x2: Second order modulator 0x3: Third order modulator All other values are not used.

# 7.6.46 R45 Register (Offset = 0x2D) [reset = 0xC622]

R45 is shown in 图 7-55 and described in 表 7-65.

Return to 表 7-18.

# 图 7-55. R45 Register

				д, . ••	o i togioto.				
	15	14	13	12	11	10	9	8	
RESERVED				OUTA	_MUX	RESERVED			
	R/W-0x6			R/W	-0x0		R/W-0x18		
	7	6	5	4	3	2	1	0	



# 图 7-55. R45 Register (continued)

RESERVED	OUTB_PWR
R/W-0x18	R/W-0x22

#### 表 7-65. R45 Register Field Descriptions

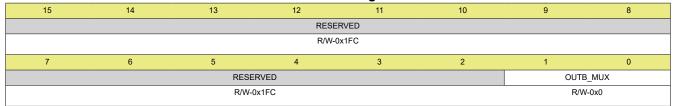
Bit	Field	Туре	Reset	Description
15-13	RESERVED	R/W	0x6	Program 0x6 to this field.
12-11	OUTA_MUX	R/W	0x0	Selects the input source to RFOUTA.  0x0 = Channel divider  0x1 = VCO  0x2 = Not used  0x3 = Reserved
10-6	RESERVED	R/W	0x18	Program 0x3 to this field.
5-0	OUTB_PWR	R/W	0x22	Sets current that controls output power for RFOUTB.  0x0 is minimum current; 0x1F is maximum current.

# 7.6.47 R46 Register (Offset = 0x2E) [reset = 0x7F0]

R46 is shown in 图 7-56 and described in 表 7-66.

Return to 表 7-18.

### 图 7-56. R46 Register



# 表 7-66. R46 Register Field Descriptions

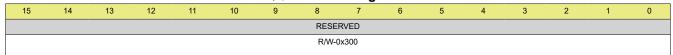
Bit	Field	Туре	Reset	Description
15-2	RESERVED	R/W	0x1FC	Program 0x1FF to this field.
1-0	OUTB_MUX	R/W		Selects the input source to RFOUTB.  0x0 = Channel divider  0x1 = VCO  0x2 = SYSREF  0x3 = Reserved

# 7.6.48 R47 Register (Offset = 0x2F) [reset = 0x300]

R47 is shown in 图 7-57 and described in 表 7-67.

Return to 表 7-18.

#### 图 7-57. R47 Register



# 表 7-67. R47 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x300	Program 0x300 to this field.

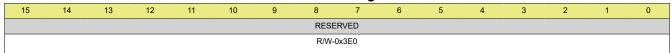
Submit Document Feedback

# 7.6.49 R48 Register (Offset = 0x30) [reset = 0x3E0]

R48 is shown in 图 7-58 and described in 表 7-68.

Return to 表 7-18.

#### 图 7-58. R48 Register



## 表 7-68. R48 Register Field Descriptions

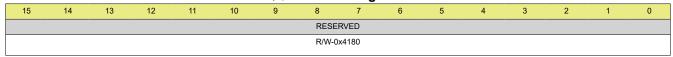
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x3E0	Program 0x300 to this field.

## 7.6.50 R49 Register (Offset = 0x31) [reset = 0x4180]

R49 is shown in 图 7-59 and described in 表 7-69.

Return to 表 7-18.

#### 图 7-59. R49 Register



# 表 7-69. R49 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x4180	Program 0x4180 to this field.

## 7.6.51 R50 Register (Offset = 0x32) [reset = 0x80]

Return to 表 7-18.

#### 图 7-60. R50 Register



# 表 7-70. R50 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x80	Program 0x0 to this field.

# 7.6.52 R51 Register (Offset = 0x33) [reset = 0x80]

R51 is shown in 图 7-61 and described in 表 7-71.

Return to 表 7-18.

#### 图 7-61. R51 Register





表 7-71. R51 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x80	Program 0x80 to this field.

#### 7.6.53 R52 Register (Offset = 0x34) [reset = 0x420]

R52 is shown in 图 7-62 and described in 表 7-72.

Return to 表 7-18.

#### 图 7-62. R52 Register



#### 表 7-72. R52 Register Field Descriptions

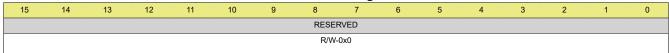
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x420	Program 0x420 to this field.

#### 7.6.54 R53 Register (Offset = 0x35) [reset = 0x0]

R53 is shown in 图 7-63 and described in 表 7-73.

Return to 表 7-18.

### 图 7-63. R53 Register



#### 表 7-73. R53 Register Field Descriptions

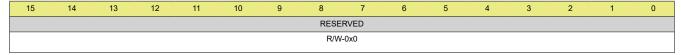
		• .		• • • • • • • • • • • • • • • • • • •
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

#### 7.6.55 R54 Register (Offset = 0x36) [reset = 0x0]

R54 is shown in 图 7-64 and described in 表 7-74.

Return to 表 7-18.

#### 图 7-64. R54 Register



# 表 7-74. R54 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

# 7.6.56 R55 Register (Offset = 0x37) [reset = 0x0]

R55 is shown in 图 7-65 and described in 表 7-75.

Return to 表 7-18.

#### 图 7-65. R55 Register



# 图 7-65. R55 Register (continued)

R/W-0x0

# 表 7-75. R55 Register Field Descriptions

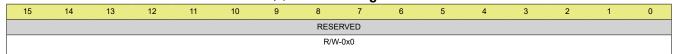
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

### 7.6.57 R56 Register (Offset = 0x38) [reset = 0x0]

R56 is shown in 图 7-66 and described in 表 7-76.

Return to 表 7-18.

# 图 7-66. R56 Register



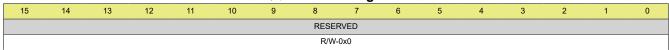
### 表 7-76. R56 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

#### 7.6.58 R57 Register (Offset = 0x39) [reset = 0x0]

Return to 表 7-18.

#### 图 7-67. R57 Register



#### 表 7-77. R57 Register Field Descriptions

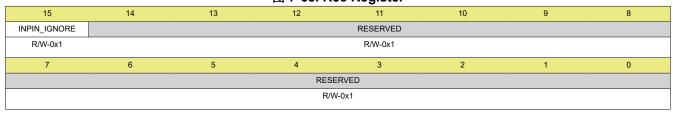
		• .	•	•
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x20 to this field.

#### 7.6.59 R58 Register (Offset = 0x3A) [reset = 0x8001]

R58 is shown in 图 7-68 and described in 表 7-78.

Return to 表 7-18.

#### 图 7-68. R58 Register



# 表 7-78. R58 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15	INPIN_IGNORE	R/W		Ignore SYNC and SYSREFREQ pins when VCO_PHASE_SYNC = 0. This bit should be set to 1 unless VCO_PHASE_SYNC = 1.
14-0	RESERVED	R/W	0x1	Program 0x1 to this field.

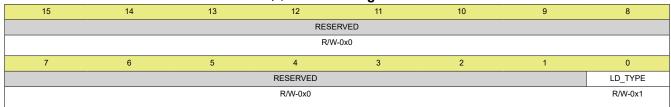


# 7.6.60 R59 Register (Offset = 0x3B) [reset = 0x1]

R59 is shown in 图 7-69 and described in 表 7-79.

Return to 表 7-18.

# 图 7-69. R59 Register



# 表 7-79. R59 Register Field Descriptions

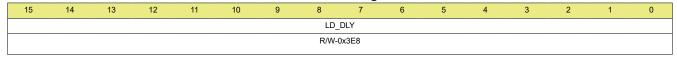
Bit	Field	Туре	Reset	Description
15-1	RESERVED	R/W	0x0	Program 0x0 to this field.
0	LD_TYPE	R/W	0x1	Lock detect type.  VCOCal lock detect asserts a high output after the VCO has finished calibration and the LD_DLY timeout counter is finished.  Vtune and VCOCal lock detect asserts a high output when VCOCal lock detect would assert a signal and the tuning voltage to the VCO is within acceptable limits.  0x0 = VCOCal lock detect 0x1 = VCOCal and Vtune lock detect

# 7.6.61 R60 Register (Offset = 0x3C) [reset = 0x3E8]

R60 is shown in 图 7-70 and described in 表 7-80.

Return to 表 7-18.

### 图 7-70. R60 Register



# 表 7-80. R60 Register Field Descriptions

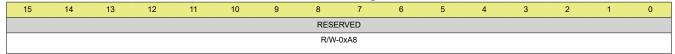
Bit	Field	Туре	Reset	Description
15-0	LD_DLY	R/W		For the VCOCal lock detect, this is the delay in 1/4 $f_{PD}$ cycles that is added after the calibration is finished before the VCOCal lock detect is asserted high.

# 7.6.62 R61 Register (Offset = 0x3D) [reset = 0xA8]

R61 is shown in 图 7-71 and described in 表 7-81.

Return to 表 7-18.

# 图 7-71. R61 Register



# 表 7-81. R61 Register Field Descriptions

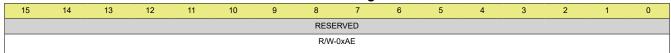
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0xA8	Program 0xA8 to this field.

# 7.6.63 R62 Register (Offset = 0x3E) [reset = 0xAE]

R62 is shown in 图 7-72 and described in 表 7-82.

Return to 表 7-18.

# 图 7-72. R62 Register



## 表 7-82. R62 Register Field Descriptions

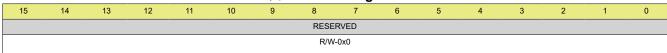
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0xAE	Program 0x322 to this field.

## 7.6.64 R63 Register (Offset = 0x3F) [reset = 0x0]

R63 is shown in 图 7-73 and described in 表 7-83.

Return to 表 7-18.

### 图 7-73. R63 Register



# 表 7-83. R63 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

## 7.6.65 R64 Register (Offset = 0x40) [reset = 0x1388]

R64 is shown in 图 7-74 and described in 表 7-84.

Return to 表 7-18.

#### 图 7-74. R64 Register



#### 表 7-84. R64 Register Field Descriptions

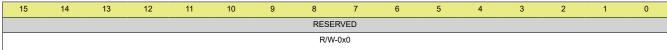
Bit Field		Туре	Reset	Description
15-0	RESERVED	R/W	0x1388	Program 0x1388 to this field.

# 7.6.66 R65 Register (Offset = 0x41) [reset = 0x0]

R65 is shown in 图 7-75 and described in 表 7-85.

Return to 表 7-18.

# 图 7-75. R65 Register



Copyright © 2022 Texas Instruments Incorporated



表 7-85. R65 Register Field Descriptions

Bit Field		Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

#### 7.6.67 R66 Register (Offset = 0x42) [reset = 0x140]

R66 is shown in 图 7-76 and described in 表 7-86.

Return to 表 7-18.

### 图 7-76. R66 Register



#### 表 7-86. R66 Register Field Descriptions

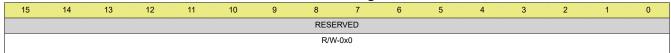
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x140	Program 0x1F4 to this field.

#### 7.6.68 R67 Register (Offset = 0x43) [reset = 0x0]

R67 is shown in 图 7-77 and described in 表 7-87.

Return to 表 7-18.

### 图 7-77. R67 Register



#### 表 7-87. R67 Register Field Descriptions

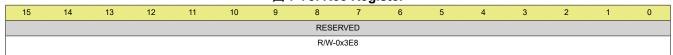
		• .		• • • • • • • • • • • • • • • • • • •
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

#### 7.6.69 R68 Register (Offset = 0x44) [reset = 0x3E8]

R68 is shown in 图 7-78 and described in 表 7-88.

Return to 表 7-18.

#### 图 7-78. R68 Register



# 表 7-88. R68 Register Field Descriptions

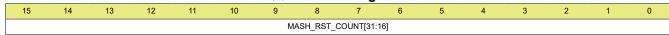
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x3E8	Program 0x3E8 to this field.

# 7.6.70 R69 Register (Offset = 0x45) [reset = 0x0]

R69 is shown in 图 7-79 and described in 表 7-89.

Return to 表 7-18.

#### 图 7-79. R69 Register



# 图 7-79. R69 Register (continued)

R/W-0x0

# 表 7-89. R69 Register Field Descriptions

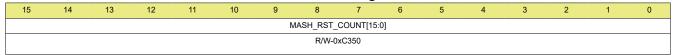
Bit	Field	Туре	Reset	Description
15-0		R/W	0x0	Upper 16 bits of MASH_RST_COUNT.
	[6]			

# 7.6.71 R70 Register (Offset = 0x46) [reset = 0xC350]

R70 is shown in 图 7-80 and described in 表 7-90.

Return to 表 7-18.

### 图 7-80. R70 Register



# 表 7-90. R70 Register Field Descriptions

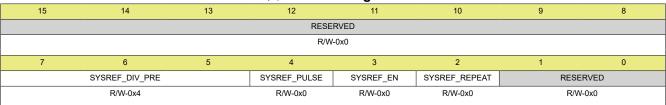
Bit	Field	Туре	Reset	Description
15-0	MASH_RST_COUNT[15:0]	R/W		Lower 16 bits of MASH_RST_COUNT. This register is used to add a delay when using phase SYNC. The delay should be set at least four times the PLL lock time. This delay is expressed in state machine clock periods. One of these periods is equal to 2 <sup>CAL_CLK_DIV</sup> / f <sub>OSC</sub> .

# 7.6.72 R71 Register (Offset = 0x47) [reset = 0x80]

R71 is shown in 图 7-81 and described in 表 7-91.

Return to 表 7-18.

# 图 7-81. R71 Register



# 表 7-91. R71 Register Field Descriptions

Bit	Field	Туре	Reset	Description		
15-8	RESERVED	R/W	0x0	Program 0x0 to this field.		
7-5	interpola 0x2 = Di		0x4	This divider is used to get the frequency input to the SYSREF interpolater within acceptable limits.  0x2 = Divided by 2  0x4 = Divided by 4		
4	SYSREF_PULSE	R/W	0x0	When in master mode (SYSREF_REPEAT = 0), this allows multiple pulses (as determined by SYSREF_PULSE_CNT) to be sent out whenever the SYSREFREQ pin goes high.  0x0 = Disabled  0x1 = Enable		
3	SYSREF_EN	R/W 0x0 Enables SYSREF mode. 0x0 = Disabled 0x1 = Enabled		0x0 = Disabled		

表 7-91. R71 Register Field Descriptions (continued)

Bit Field Type Reset Description					Description				
	2	SYSREF_REPEAT	R/W	0x0	Defines SYSREF mode. In Master mode, SYSREF pulses are generated continuously at the output. In Repeater mode, SYSREF pulses are generated in response to the SYSREFREQ pin.  0x0 = Master mode  0x1 = Repeater Mode				
	1-0	RESERVED	R/W	0x0	Program 0x0 to this field.				

# 7.6.73 R72 Register (Offset = 0x48) [reset = 0x1]

R72 is shown in 图 7-82 and described in 表 7-92.

Return to 表 7-18.

# 图 7-82. R72 Register

15	14	13	12	11	10	9	8
		RESERVED	SYSREF_DIV				
		R/W-0x0			R/W-0x1		
7	6	5	4	3	2	1	0
			SYSRE	F_DIV			
			R/W	-0x1			

# 表 7-92. R72 Register Field Descriptions

	Bit	Field	Туре	Reset	Description
	15-11	15-11 RESERVED R/W 0x0 Program 0x		Program 0x0 to this field.	
Ī	10-0	SYSREF_DIV	R/W	0x1	This divider further divides the output frequency for the SYSREF.

# 7.6.74 R73 Register (Offset = 0x49) [reset = 0x3F]

R73 is shown in 图 7-83 and described in 表 7-93.

Return to 表 7-18.

### 图 7-83. R73 Register

			Д, . ОО					
15	14	13	12	11	10	9	8	
	RESE	RVED		JESD_DAC2_CTRL				
	R/W-	0x0		R/W-0x0				
7	6	5	4	3	2	1	0	
JESD_D	AC2_CTRL			JESD_DAC1_CTRL				
R/	W-0x0			R/W-0	)x3F			

# 表 7-93. R73 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-12	RESERVED	R/W	0x0	Program 0x0 to this field.
11-6	JESD_DAC2_CTRL	R/W	0x0	Programmable delay adjustment for SYSREF mode.
5-0	JESD_DAC1_CTRL	R/W	0x3F	Programmable delay adjustment for SYSREF mode.

# 7.6.75 R74 Register (Offset = 0x4A) [reset = 0x0]

R74 is shown in 图 7-84 and described in 表 7-94.

Return to 表 7-18.

#### 图 7-84. R74 Register

15	14	13	12	11	10	9	8		
	SYSREF_P	ULSE_CNT		JESD_DAC4_CTRL					
	R/W	/-0x0		R/W-0x0					
7	6	5	4	3	2	1	0		
JESD_DA	AC4_CTRL			JESD_DAC3_CTRL					
R/W	/-0x0	R/W-0x0							

# 表 7-94. R74 Register Field Descriptions

	Bit	Field	Туре	Reset	Description
1	15-12	SYSREF_PULSE_CNT	R/W		Used in SYSREF_REPEAT mode to define how many pulses are sent.
	11-6	JESD_DAC4_CTRL	R/W	0x0	Programmable delay adjustment for SYSREF mode.
	5-0	JESD_DAC3_CTRL	R/W	0x0	Programmable delay adjustment for SYSREF mode.

# 7.6.76 R75 Register (Offset = 0x4B) [reset = 0x800]

R75 is shown in 图 7-85 and described in 表 7-95.

Return to 表 7-18.

# 图 7-85. R75 Register

	15	14	13	12	11	10	9	8		
			RESERVED		CHDIV					
			R/W-0x1				R/W-0x0			
	7	6	5	4	3	2	1	0		
Ī	CHD	DIV	RESERVED							
	R/W-	0x0	R/W-0x0							
ı										

# 表 7-95. R75 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	RESERVED	R/W	0x1	Program 0x1 to this field.
10-6	CHDIV	R/W	0x0	Channel divider.  0x0 = Divide by 2  0x1 = Divide by 4  0x2 = Divide by 6  0x3 = Divide by 8  0x4 = Divide by 12  0x5 = Divide by 16  0x6 = Divide by 24  0x7 = Divide by 32  0x8 = Divide by 48  0x9 = Divide by 64  0xA = Divide by 96  0xB = Divide by 128  0xC = Divide by 192
5-0	RESERVED	R/W	0x0	Program 0x0 to this field.

# 7.6.77 R76 Register (Offset = 0x4C) [reset = 0xC]

R76 is shown in 图 7-86 and described in 表 7-96.

Return to 表 7-18.

# 图 7-86. R76 Register





#### 图 7-86. R76 Register (continued)

# 表 7-96. R76 Register Field Descriptions

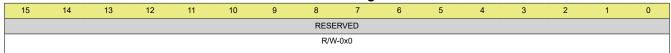
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0xC	Program 0xC to this field.

# 7.6.78 R77 Register (Offset = 0x4D) [reset = 0x0]

R77 is shown in 图 7-87 and described in 表 7-97.

Return to 表 7-18.

#### 图 7-87. R77 Register



# 表 7-97. R77 Register Field Descriptions

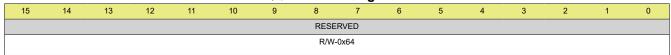
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

# 7.6.79 R78 Register (Offset = 0x4E) [reset = 0x64]

R78 is shown in 图 7-88 and described in 表 7-98.

Return to 表 7-18.

#### 图 7-88. R78 Register



## 表 7-98. R78 Register Field Descriptions

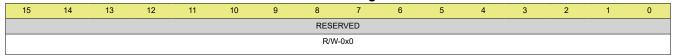
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x64	Program 0x64 to this field.

### 7.6.80 R79 Register (Offset = 0x4F) [reset = 0x0]

R79 is shown in 87-89 and described in 7-89.

Return to 表 7-18.

#### 图 7-89. R79 Register



#### 表 7-99. R79 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

# 7.6.81 R80 Register (Offset = 0x50) [reset = 0x0]

R80 is shown in 图 7-90 and described in 表 7-100.

Return to 表 7-18.

## 图 7-90. R80 Register

						-	00								
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RESERVED															
	R/W-0x0														

### 表 7-100. R80 Register Field Descriptions

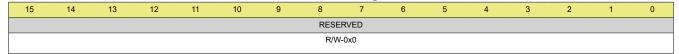
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

# 7.6.82 R81 Register (Offset = 0x51) [reset = 0x0]

R81 is shown in 图 7-91 and described in 表 7-101.

Return to 表 7-18.

#### 图 7-91. R81 Register



### 表 7-101. R81 Register Field Descriptions

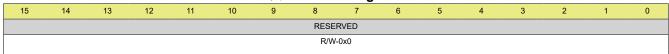
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

### 7.6.83 R82 Register (Offset = 0x52) [reset = 0x0]

R82 is shown in 图 7-92 and described in 表 7-102.

Return to 表 7-18.

#### 图 7-92. R82 Register



# 表 7-102. R82 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

# 7.6.84 R83 Register (Offset = 0x53) [reset = 0x0]

R83 is shown in 图 7-93 and described in 表 7-103.

Return to 表 7-18.

#### 图 7-93. R83 Register



# 表 7-103. R83 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

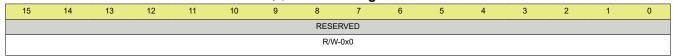
# 7.6.85 R84 Register (Offset = 0x54) [reset = 0x0]

R84 is shown in 图 7-94 and described in 表 7-104.



Return to 表 7-18.

#### 图 7-94. R84 Register



#### 表 7-104. R84 Register Field Descriptions

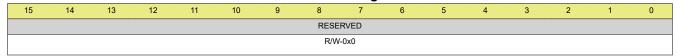
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

# 7.6.86 R85 Register (Offset = 0x55) [reset = 0x0]

R85 is shown in 图 7-95 and described in 表 7-105.

Return to 表 7-18.

### 图 7-95. R85 Register



#### 表 7-105. R85 Register Field Descriptions

_					
	Bit	Field	Туре	Reset	Description
	15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

# 7.6.87 R86 Register (Offset = 0x56) [reset = 0x0]

R86 is shown in 图 7-96 and described in 表 7-106.

Return to 表 7-18.

#### 图 7-96. R86 Register



#### 表 7-106. R86 Register Field Descriptions

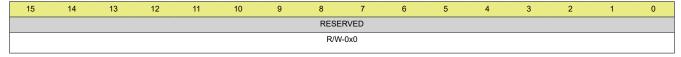
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

# 7.6.88 R87 Register (Offset = 0x57) [reset = 0x0]

R87 is shown in 图 7-97 and described in 表 7-107.

Return to 表 7-18.

#### 图 7-97. R87 Register



#### 表 7-107. R87 Register Field Descriptions

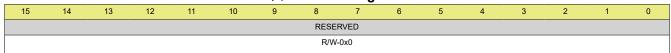
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

Submit Document Feedback

#### 7.6.89 R88 Register (Offset = 0x58) [reset = 0x0]

Return to 表 7-18.

## 图 7-98. R88 Register



# 表 7-108. R88 Register Field Descriptions

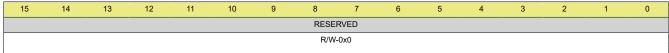
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

## 7.6.90 R89 Register (Offset = 0x59) [reset = 0x0]

R89 is shown in 图 7-99 and described in 表 7-109.

Return to 表 7-18.

# 图 7-99. R89 Register



### 表 7-109. R89 Register Field Descriptions

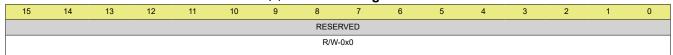
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

# 7.6.91 R90 Register (Offset = 0x5A) [reset = 0x0]

R90 is shown in 图 7-100 and described in 表 7-110.

Return to 表 7-18.

#### 图 7-100. R90 Register



# 表 7-110. R90 Register Field Descriptions

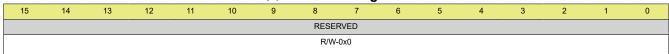
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

# 7.6.92 R91 Register (Offset = 0x5B) [reset = 0x0]

R91 is shown in 图 7-101 and described in 表 7-111.

Return to 表 7-18.

#### 图 7-101. R91 Register



Copyright © 2022 Texas Instruments Incorporated



表 7-111. R91 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

#### 7.6.93 R92 Register (Offset = 0x5C) [reset = 0x0]

R92 is shown in 图 7-102 and described in 表 7-112.

Return to 表 7-18.

#### 图 7-102. R92 Register



#### 表 7-112. R92 Register Field Descriptions

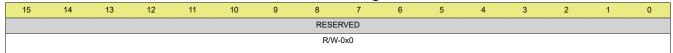
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

# 7.6.94 R93 Register (Offset = 0x5D) [reset = 0x0]

R93 is shown in 图 7-103 and described in 表 7-113.

Return to 表 7-18.

# 图 7-103. R93 Register



#### 表 7-113. R93 Register Field Descriptions

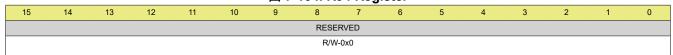
		• •		• • • • • • • • • • • • • • • • • • •
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

# 7.6.95 R94 Register (Offset = 0x5E) [reset = 0x0]

R94 is shown in 图 7-104 and described in 表 7-114.

Return to 表 7-18.

#### 图 7-104. R94 Register



# 表 7-114. R94 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

# 7.6.96 R95 Register (Offset = 0x5F) [reset = 0x0]

Return to 表 7-18.

#### 图 7-105. R95 Register



#### 图 7-105. R95 Register (continued)

R/W-0x0

# 表 7-115. R95 Register Field Descriptions

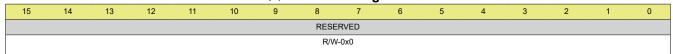
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

### 7.6.97 R96 Register (Offset = 0x60) [reset = 0x0]

R96 is shown in 图 7-106 and described in 表 7-116.

Return to 表 7-18.

# 图 7-106. R96 Register



### 表 7-116. R96 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

#### 7.6.98 R97 Register (Offset = 0x61) [reset = 0x0]

R97 is shown in  $\boxtimes$  7-107 and described in  $\textcircled{\pi}$  7-117.

Return to 表 7-18.

#### 图 7-107. R97 Register



#### 表 7-117. R97 Register Field Descriptions

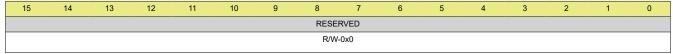
		• •	-	•
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

#### 7.6.99 R98 Register (Offset = 0x62) [reset = 0x0]

R98 is shown in 图 7-108 and described in 表 7-118.

Return to 表 7-18.

#### 图 7-108. R98 Register



#### 表 7-118. R98 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

# 7.6.100 R99 Register (Offset = 0x63) [reset = 0x0]

R99 is shown in 图 7-109 and described in 表 7-119.

Return to 表 7-18.



# 图 7-109. R99 Register

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	RESERVED														
	R/W-0x0														

#### 表 7-119. R99 Register Field Descriptions

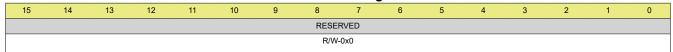
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

# 7.6.101 R100 Register (Offset = 0x64) [reset = 0x0]

R100 is shown in 图 7-110 and described in 表 7-120.

Return to 表 7-18.

#### 图 7-110. R100 Register



### 表 7-120. R100 Register Field Descriptions

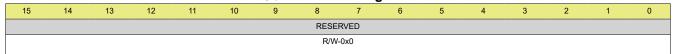
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

### 7.6.102 R101 Register (Offset = 0x65) [reset = 0x0]

R101 is shown in 图 7-111 and described in 表 7-121.

Return to 表 7-18.

#### 图 7-111. R101 Register



# 表 7-121. R101 Register Field Descriptions

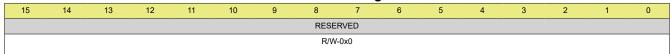
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

# 7.6.103 R102 Register (Offset = 0x66) [reset = 0x0]

R102 is shown in 图 7-112 and described in 表 7-122.

Return to 表 7-18.

#### 图 7-112. R102 Register



# 表 7-122. R102 Register Field Descriptions

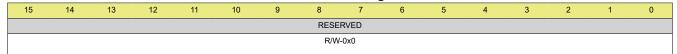
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

# 7.6.104 R103 Register (Offset = 0x67) [reset = 0x0]

R103 is shown in 图 7-113 and described in 表 7-123.

Return to 表 7-18.

### 图 7-113. R103 Register



### 表 7-123. R103 Register Field Descriptions

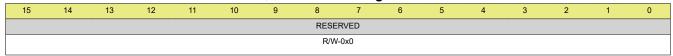
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

### 7.6.105 R104 Register (Offset = 0x68) [reset = 0x0]

R104 is shown in 图 7-114 and described in 表 7-124.

Return to 表 7-18.

# 图 7-114. R104 Register



#### 表 7-124. R104 Register Field Descriptions

_					
	Bit	Field	Туре	Reset	Description
	15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

# 7.6.106 R105 Register (Offset = 0x69) [reset = 0x440]

R105 is shown in 图 7-115 and described in 表 7-125.

Return to 表 7-18.

#### 图 7-115. R105 Register



#### 表 7-125. R105 Register Field Descriptions

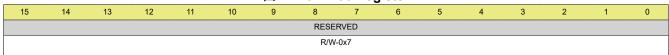
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x440	Program 0x0 to this field.

# 7.6.107 R106 Register (Offset = 0x6A) [reset = 0x7]

R106 is shown in 图 7-116 and described in 表 7-126.

Return to 表 7-18.

#### 图 7-116. R106 Register



### 表 7-126. R106 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x7	Program 0x0 to this field.

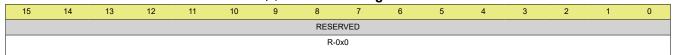
Copyright © 2022 Texas Instruments Incorporated

#### 7.6.108 R107 Register (Offset = 0x6B) [reset = 0x0]

R107 is shown in 图 7-117 and described in 表 7-127.

Return to 表 7-18.

## 图 7-117. R107 Register



# 表 7-127. R107 Register Field Descriptions

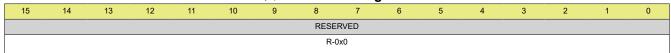
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R	0x0	Not used. Read back only.

## 7.6.109 R108 Register (Offset = 0x6C) [reset = 0x0]

R108 is shown in 图 7-118 and described in 表 7-128.

Return to 表 7-18.

### 图 7-118. R108 Register



# 表 7-128. R108 Register Field Descriptions

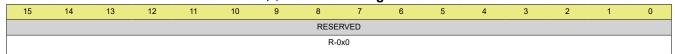
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R	0x0	Not used. Read back only.

## 7.6.110 R109 Register (Offset = 0x6D) [reset = 0x0]

R109 is shown in  $\boxtimes$  7-119 and described in 7 7-129.

Return to 表 7-18.

#### 图 7-119. R109 Register



#### 表 7-129. R109 Register Field Descriptions

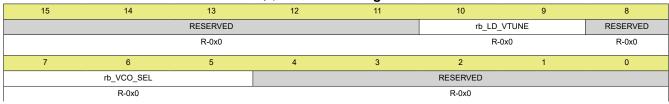
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R	0x0	Not used. Read back only.

# 7.6.111 R110 Register (Offset = 0x6E) [reset = 0x0]

R110 is shown in 图 7-120 and described in 表 7-130.

Return to 表 7-18.

# 图 7-120. R110 Register



# 图 7-120. R110 Register (continued)

# 表 7-130. R110 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-11	RESERVED	R	0x0	Not used. Read back only.
10-9	rb_LD_VTUNE	R	0x0	Readback field for the lock detect.  0x0 = Unlocked (f <sub>VCO</sub> Low)  0x1 = Invalid  0x2 = Locked  0x3 = Unlocked (f <sub>VCO</sub> High)
8	RESERVED	R	0x0	Not used. Read back only.
7-5	rb_VCO_SEL	R	0x0	Reads back the actual VCO that the calibration has selected.  0x1 = VCO1  0x2 = VCO2   0x7 = VCO7
4-0	RESERVED	R	0x0	Not used. Read back only.

# 7.6.112 R111 Register (Offset = 0x6F) [reset = 0x0]

R111 is shown in 图 7-121 and described in 表 7-131.

Return to 表 7-18.

### 图 7-121. R111 Register

					- 5						
	15	14	13	12	11	10	9	8			
			RESERVED								
	R-0x0										
	7	6	5	4	3	2	1	0			
Ī	rb_VCO_CAPCTRL										
		R-0x0									

# 表 7-131. R111 Register Field Descriptions

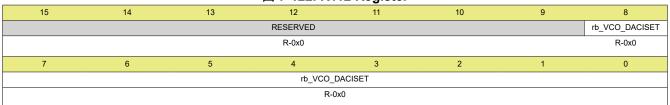
Bit	Field	Туре	Reset	Description
15-8	RESERVED	R	0x0	Not used. Read back only.
7-0	rb_VCO_CAPCTRL	R		Readback field for the actual VCO_CAPCTRL value that is chosen by the VCO calibration.

# 7.6.113 R112 Register (Offset = 0x70) [reset = 0x0]

R112 is shown in 图 7-122 and described in 表 7-132.

Return to 表 7-18.

# 图 7-122. R112 Register



# 表 7-132. R112 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-9	RESERVED	R	0x0	Not used. Read back only.



表 7-132. R112 Register Field Descriptions (continued)

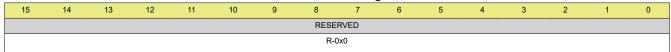
Bit	Field	Туре	Reset	Description
8-0	rb_VCO_DACISET	R		Readback field for the actual VCO_DACISET value that is chosen by the VCO calibration.

# 7.6.114 R113 Register (Offset = 0x71) [reset = 0x0]

R113 is shown in 图 7-123 and described in 表 7-133.

Return to 表 7-18.

# 图 7-123. R113 Register



### 表 7-133. R113 Register Field Descriptions

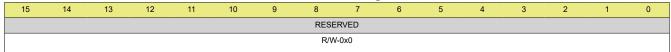
Bit	Field	Туре	Reset	Description
15-0	RESERVED	R	0x0	Not used. Read back only.

# 7.6.115 R114 Register (Offset = 0x72) [reset = 0x0]

R114 is shown in 图 7-124 and described in 表 7-134.

Return to 表 7-18.

#### 图 7-124. R114 Register



#### 表 7-134. R114 Register Field Descriptions

Bit	Field	Туре	Reset	Description
15-0	RESERVED	R/W	0x0	Program 0x0 to this field.

Submit Document Feedback

# 8 Application and Implementation

# 备注

以下应用部分中的信息不属于 TI 器件规格的范围, TI 不担保其准确性和完整性。TI 的客户应负责确定器件是否适用于其应用。客户应验证并测试其设计,以确保系统功能。

# 8.1 Application Information

# 8.1.1 OSCIN Configuration

OSCIN supports single or differential-ended clock. There must be a AC-coupling capacitor in series before the device pin. The OSCIN inputs are high-impedance CMOS with internal bias voltage. TI recommends putting termination shunt resistors to terminate the differential traces (if there are  $50-\Omega$  characteristic traces, place  $50-\Omega$  resistors). The OSCIN\_P and OSCIN\_N side must be matched in layout. A series AC-coupling capacitors must immediately follow OSCIN pins in the board layout, then the shunt termination resistors to ground must be placed after.

Input clock definitions are shown in \textstyle 8-1.

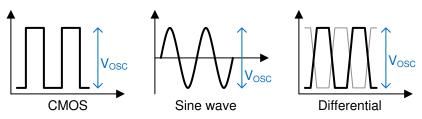


图 8-1. Input Clock Definitions

#### 8.1.2 OSCIN Slew Rate

The slew rate of the OSCIN signal can have an impact on the spurs and phase noise of the LMX2694-EP if it is too low. In general, the best performance is for a high slew rate, but lower amplitude signal, such as LVDS.

#### 8.1.3 RF Output Buffer Power Control

The OUTA\_PWR and OUTB\_PWR registers control the amount of drive current for the output. This current creates a voltage across the pullup component and load. TI generally recommends to keep the OUTx\_PWR setting at 31 or less, as higher settings consume more current consumption and can also lead to higher output power. Optimal noise floor is typically obtained by setting OUTx\_PWR in the range of 15 to 25.

#### 8.1.4 RF Output Buffer Pullup

The choice of output buffer components is very important and can have a profound impact on the output power. The pullup component can be a resistor or inductor or combination thereof. The signal swing is created by a current flowing this pullup, so a higher impedance implies a higher signal swing. However, as this pullup component can be treated as if it is in parallel with the load impedance, there are diminishing returns as the impedance gets much larger than the load impedance. The output impedance of the device varies as a function of frequency and is a complex number, but typically has a magnitude on the order of 100  $\Omega$ , but this decreases with frequency.

The output can be used differentially or single-ended. If using single-ended, the pullup is still needed, and user needs to terminate the unused complimentary side such that the impedance as seen from the pin looking out is similar to the pin that is being used. Following are some typical components that might be useful.

Copyright © 2022 Texas Instruments Incorporated

表 8-1. Output Pullup Configura	tion
--------------------------------	------

COMPONENT	VALUE	PART NUMBER
	1 nH, 13.6 GHz SRF	Toko LL1005-FH1N0S
Inductor	3.3 nH, 6.8 GHz SRF	Toko LL1005-FH3N3S
	10 nH, 3.8 GHz SRF	Toko LL1005-FH10NU
Resistor	50 Ω	Vishay FC0402E50R0BST1
Capacitor	Varies with frequency	ATC 520L103KT16T ATC 504L50R0FTNCFT

#### 8.1.4.1 Resistor Pullup

One strategy for the choice of the pullup component is to use a resistor (R). This is typically chosen to be 50- $\Omega$  and under the assumption that the part output impedance is high, then the output impedance will theoretically be 50  $\Omega$ , regardless of output frequency. As the output impedance of the device is not infinite, the output impedance when the pullup resistor is used will be less than 50  $\Omega$ , but will be reasonably close. There will be some drop across the resistor, but this does not seem to have a large impact on signal swing for a 50- $\Omega$  resistor provided that OUTx PWR  $\leq$  31.

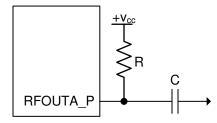


图 8-2. Resistor Pullup

#### 8.1.4.2 Inductor Pullup

Another strategy is to choose an inductor pullup (L). This allows a higher impedance without any concern of creating any DC drop across the component. Ideally, the inductor should be chosen large enough so that the impedance is high relative to the load impedance and also be operating away from its self-resonant frequency. For instance, consider a 3.3-nH pullup inductor with a self-resonant frequency of 7 GHz driving a 25- $\Omega$  spectrum analyzer input. This inductor theoretically has j50- $\Omega$  input impedance around 2.4 GHz. At this frequency, this in parallel with load is about j35- $\Omega$ , which is a 3-dB power reduction. At 1.4 GHz, this inductor has impedance of about 29  $\Omega$ . This in parallel with the 50- $\Omega$  load has a magnitude of 25  $\Omega$ , which is the same result seen with the 50- $\Omega$  pullup. The main issue with the inductor pullup is that the impedance does not look nicely matched to the load.

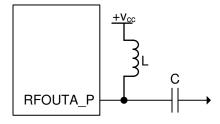


图 8-3. Inductor Pullup

As the output impedance is not so nicely matched, but there is higher output power, it makes sense to use a resistive pad to get the best impedance control. A 6-dB pad (R1 = 18  $\,^{\Omega}$ , R2 = 68  $\,^{\Omega}$ ) is likely more attenuation than necessary. A 3-dB or even 1-dB pad might suffice. Two AC-coupling capacitors are required before the pad. In  $\,^{\square}$ 8-4, one of them is placed by the resistor to ground to minimize the number of components in the high frequency path for lower loss.

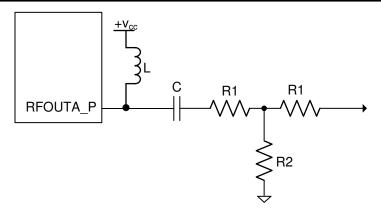


图 8-4. Inductor Pullup With Pad

For the resistive pad, 表 8-2 shows some common values:

20 2. Resistive 11 du values									
ATTENUATION	R1	R2							
1 dB	2.7 Ω	420 Ω							
2 dB	5.6 Ω	220 Ω							
3 dB	6.8 Ω	150 Ω							
4 dB	<b>12</b> Ω	100 Ω							
5 dB	15 Ω	<b>82</b> Ω							
6 dB	18 Ω	68 Ω							

表 8-2. Resistive T-Pad Values

# 8.1.4.3 Combination Pullup

The resistor gives a good low frequency response, while the inductor gives a good high frequency response with worse matching. It is desirable to have the impedance of the pullup to be high, but if a resistor is used, then there could be too much DC drop. If an inductor is used, it is hard to find one good at low frequencies and around its self-resonant frequency. One approach to address this is to use a series resistor and inductor followed by resistive pad.

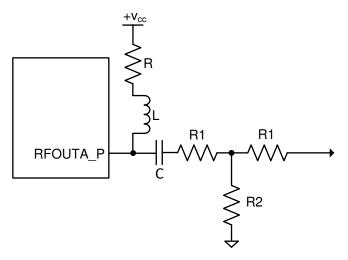


图 8-5. Inductor and Resistor Pullup

# 8.1.5 RF Output Treatment for the Complimentary Side

Regardless of whether both sides of the differential outputs are used, both sides should see a similar load.

# 8.1.5.1 Single-Ended Termination of Unused Output

The unused output should see a roughly the same impedance as looking out of the pin to minimize harmonics and get the best output power. As placement of the pull-up components is critical for the best output power, the routing does not need to be perfectly symmetrical. It makes sense to give highest priority routing to the used output (RFOUTA\_P in this case).

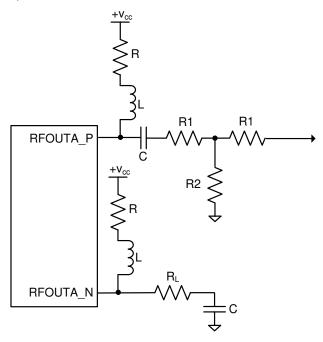


图 8-6. Termination of Unused Output - Single-Ended

#### 8.1.5.2 Differential Termination

For differential termination this can be done by doing the same termination to both sides, or it is also possible to connect the grounds together. This approach can also be accompanied by a differential to single-ended balun for the highest possible output power.

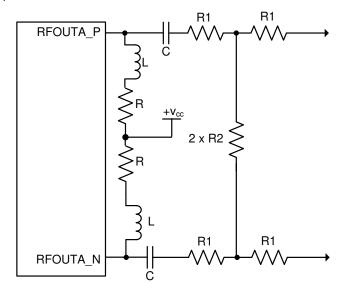


图 8-7. Termination of Unused Output - Differential

#### 8.1.6 External Loop Filter

The LMX2694-EP requires an external loop filter that is application-specific and can be configured by PLLatinum Sim. For the LMX2694-EP, it matters what impedance is seen from the VTUNE pin looking outwards. This impedance is dominated by the component C3 for a third order filter or C1 for a second order filter. If there is at least 1.5 nF for the capacitance that is shunt with this pin, the VCO phase noise will be close to the best it can be. If there is less, the VCO phase noise in the 100-kHz to 1-MHz region will degrade. This capacitor should be placed close to the VTUNE pin.

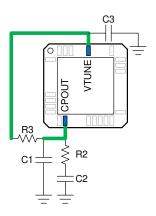


图 8-8. External Loop Filter

# 8.2 Typical Application

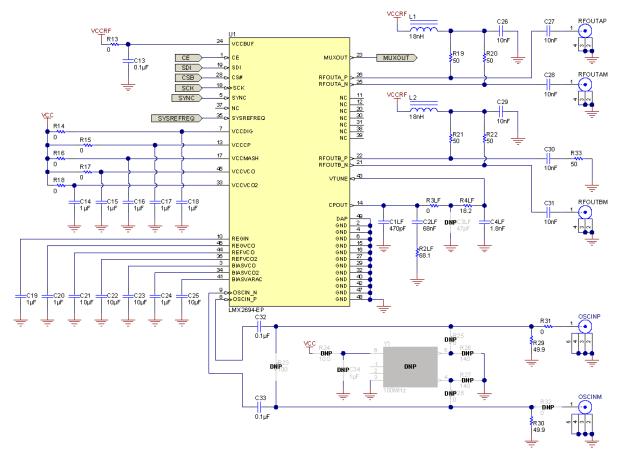


图 8-9. Typical Application Schematic

#### 8.2.1 Design Requirements

The design of the loop filter is complex and is typically done with software. The PLLatinum Sim software is an excellent resource for doing this and the design is shown in 图 8-10.

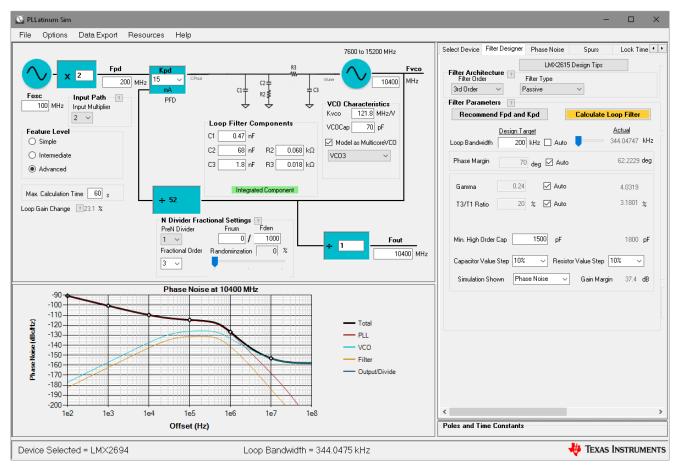


图 8-10. PLLatinum Sim Tool

#### 8.2.2 Detailed Design Procedure

The integration of phase noise over a certain bandwidth (jitter) is an performance specification that translates to signal-to-noise ratio. Phase noise inside the loop bandwidth is dominated by the PLL, while the phase noise outside the loop bandwidth is dominated by the VCO. Generally, jitter is lowest if loop bandwidth is designed to the point where the two intersect. A higher phase margin loop filter design has less peaking at the loop bandwidth and thus lower jitter. The tradeoff with this is that longer lock times and spurs must be considered in design as well.

#### 8.2.3 Application Curve

Using the settings described, the performance measured using a clean 100-MHz input reference is shown. Note the loop bandwidth is about 350 kHz, as simulations predict.

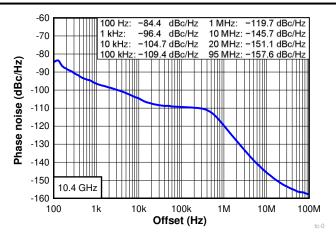


图 8-11. Results for Loop Filter Design

# 9 Power Supply Recommendations

TI recommends placement of bypass capacitors close to the pins. Consult the EVM instructions for layout examples. If fractional spurs are a large concern, using a ferrite bead to each of these power supply pins can reduce spurs to a small degree. This device has integrated LDOs, which improves the resistance to power supply noise. However, the pullup components on the RFOUTA and RFOUTB pins on the outputs have a direct connection to the power supply, so take extra care to ensure that the voltage is clean for these pins.

# 10 Layout

# 10.1 Layout Guidelines

In general, the layout guidelines are similar to most other PLL devices. Here are some specific guidelines.

- · GND pins may be routed on the package back to the DAP.
- The OSCIN pins, these are internally biased and must be AC coupled.
- If not used, the SYSREFREQ may be grounded to the DAP.
- For optimal VCO phase noise in the 200 kHz to 1 MHz range, it is ideal that the capacitor closest to the VTUNE pin be at least 3.3 nF. As requiring this larger capacitor may restrict the loop bandwidth, this value can be reduced (to say 1.5 nF) at the expense of VCO phase noise.
- For the outputs, keep the pullup component as close as possible to the pin and use the same component on each side of the differential pair.
- If a single-ended output is needed, the other side must have the same loading and pullup. However, the routing for the used side can be optimized by routing the complementary side through a via to the other side of the board. On this side, use the same pullup and make the load look equivalent to the side that is used.
- Ensure DAP on device is well-grounded with many vias, preferably copper filled.
- Have a thermal pad that is as large as the LMX2694-EP exposed pad. Add vias to the thermal pad to maximize thermal performance.
- Use a low loss dielectric material, such as Rogers 4350B, for optimal output power.

# 10.2 Layout Example

In addition to the layout guidelines already given, here are some additional comments for this specific layout example.

- The most critical part of the layout that the placement of the pull-up components (R19, R20, R21, and R22) is close to the pin for optimal output power.
- For this layout, all of the loop filter (C1LF, C2LF, C3LF, C4LF, R2LF, R3LF, and R4LF) are on the back side of the board. C4LF is located right underneath to the VTUNE pin. In the event that this C4LF capacitor would be open, it is recommended to move one of loop capacitors in this spot. For instance, if a 3<sup>rd</sup> order loop filter was used, technically C3LF would be non-zero and C4LF would be open. However, for this layout example that is designed for a 4<sup>th</sup> order loop filter, it would be optimal to make R3LF = 0 Ω, C3LF = open, and C4LF to be whatever C3LF would have been.

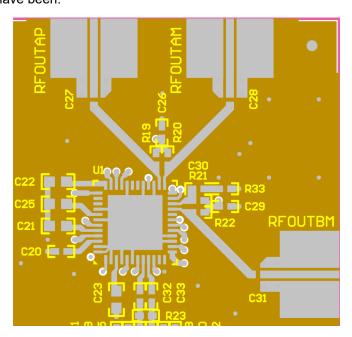


图 10-1. Layout Example

# 11 Device and Documentation Support

# 11.1 Device Support

# 11.1.1 Development Support

Texas Instruments has several software tools to aid in the development at www.ti.com. Among these tools are:

- PLLatinum Sim program for designing loop filters, simulating phase noise and spurs.
- TICS Pro software to understand how to program the device and for programming the EVM board.

## 11.2 Documentation Support

#### 11.2.1 Related Documentation

For related documentation see the following:

AN-1879 Fractional N Frequency Synthesis (SNAA062)

# 11.3 接收文档更新通知

要接收文档更新通知,请导航至 ti.com 上的器件产品文件夹。点击*订阅更新* 进行注册,即可每周接收产品信息更改摘要。有关更改的详细信息,请查看任何已修订文档中包含的修订历史记录。

# 11.4 支持资源

TI E2E<sup>™</sup> 支持论坛是工程师的重要参考资料,可直接从专家获得快速、经过验证的解答和设计帮助。搜索现有解答或提出自己的问题可获得所需的快速设计帮助。

链接的内容由各个贡献者"按原样"提供。这些内容并不构成 TI 技术规范,并且不一定反映 TI 的观点;请参阅 TI 的《使用条款》。

#### 11.5 Trademarks

PLLatinum<sup>™</sup> is a trademark of Texas Instruments.

TI E2E<sup>™</sup> is a trademark of Texas Instruments.

所有商标均为其各自所有者的财产。

#### 11.6 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

# 11.7 术语表

TI术语表本术语表列出并解释了术语、首字母缩略词和定义。

# 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

Copyright © 2022 Texas Instruments Incorporated

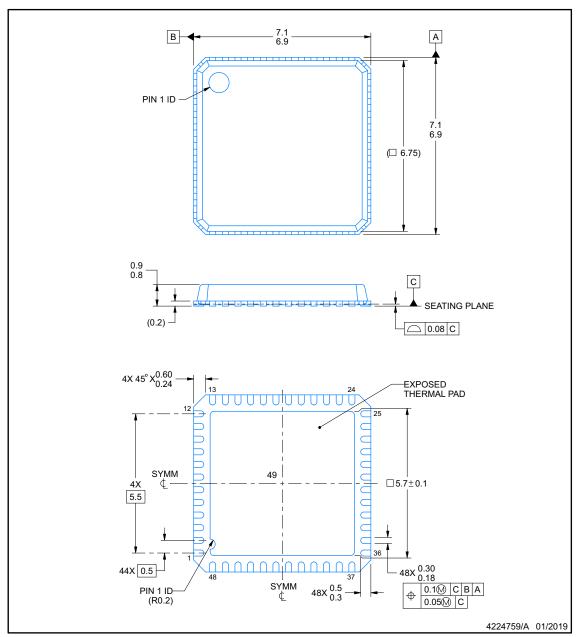


# **RTC0048G**

# **PACKAGE OUTLINE**

# VQFNP - 0.9 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



#### NOTES:

- All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
   This drawing is subject to change without notice.
   The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

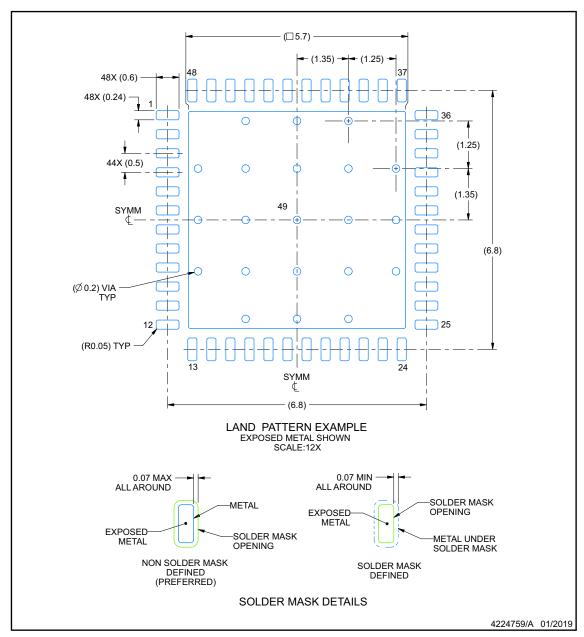


# **EXAMPLE BOARD LAYOUT**

# **RTC0048G**

# VQFNP - 0.9 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

- 4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- 5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



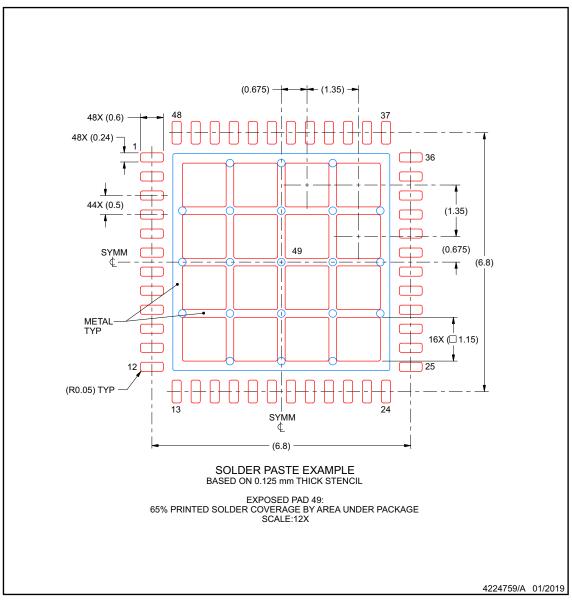


# **EXAMPLE STENCIL DESIGN**

# **RTC0048G**

VQFNP - 0.9 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



www.ti.com 6-Dec-2024

#### PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
LMX2694SRTCTEP	ACTIVE	VQFN	RTC	48	50	RoHS & Green	NIPDAUAG	Level-3-260C-168 HR	-55 to 125	LMX2694 EP	Samples
V62/19616-01XE	ACTIVE	VQFN	RTC	48	50	RoHS & Green	NIPDAUAG	Level-3-260C-168 HR	-55 to 125	LMX2694 EP	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

# **PACKAGE OPTION ADDENDUM**

www.ti.com 6-Dec-2024

#### OTHER QUALIFIED VERSIONS OF LMX2694-EP:

Catalog : LMX2694-SEP

NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

# **PACKAGE MATERIALS INFORMATION**

www.ti.com 17-May-2023

# **TAPE AND REEL INFORMATION**





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

# QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LMX2694SRTCTEP	VQFN	RTC	48	50	180.0	16.4	7.3	7.3	1.1	12.0	16.0	Q2

**PACKAGE MATERIALS INFORMATION** 

www.ti.com 17-May-2023



# \*All dimensions are nominal

	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
ı	LMX2694SRTCTEP	VQFN	RTC	48	50	210.0	185.0	35.0	

# 重要声明和免责声明

TI"按原样"提供技术和可靠性数据(包括数据表)、设计资源(包括参考设计)、应用或其他设计建议、网络工具、安全信息和其他资源,不保证没有瑕疵且不做出任何明示或暗示的担保,包括但不限于对适销性、某特定用途方面的适用性或不侵犯任何第三方知识产权的暗示担保。

这些资源可供使用 TI 产品进行设计的熟练开发人员使用。您将自行承担以下全部责任:(1) 针对您的应用选择合适的 TI 产品,(2) 设计、验证并测试您的应用,(3) 确保您的应用满足相应标准以及任何其他功能安全、信息安全、监管或其他要求。

这些资源如有变更,恕不另行通知。TI 授权您仅可将这些资源用于研发本资源所述的 TI 产品的应用。严禁对这些资源进行其他复制或展示。您无权使用任何其他 TI 知识产权或任何第三方知识产权。您应全额赔偿因在这些资源的使用中对 TI 及其代表造成的任何索赔、损害、成本、损失和债务,TI 对此概不负责。

TI 提供的产品受 TI 的销售条款或 ti.com 上其他适用条款/TI 产品随附的其他适用条款的约束。TI 提供这些资源并不会扩展或以其他方式更改 TI 针对 TI 产品发布的适用的担保或担保免责声明。

TI 反对并拒绝您可能提出的任何其他或不同的条款。

邮寄地址: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2024,德州仪器 (TI) 公司